

POWER MANAGEMENT IC FOR DIGITAL STILL CAMERA

FEATURES

- **Highly Efficient, 8-Channel Power** Management IC
- Fully Integrated Power MOSFETs (Except CH-7)
- **Minimal External Components**
- Input Voltage Range: 1.5 to 5 V
- Short-Circuit Protection (SCP) . (Except for CH-6 and CH-8)
- **Overvoltage Protection (OVP)** . (CH-2, CH-3, CH-6, and CH-7)
- **Overcurrent Protection (OCP) (CH-6)**
- Thermal Shutdown (TSD)
- **High-Accuracy Output Voltage with Trimming**
- 8 mm x 8 mm BGA Package

APPLICATIONS

Digital Still Cameras

DESCRIPTION

The TPS65520 is a highly efficient, 8-channel power management IC for digital still cameras (DSCs) integrating power MOSFETs. The device operates from an input voltage range of 1.5 V to 5 V.

The optimized circuit configuration maintains stable regulation characteristics while minimizing the number of external components required for phase compensation and other purposes.

The TPS65520 controls each output channel by communicating with the Sub-CPU through a serial interface.

| NAME ⁽¹⁾ | CIRCUIT CONFIGURATION | OUTPUT VOLTAGE [V] | ADJUSTABLE PARAMETER | POWER MOSFET | RECTIFICATION | PURPOSE |
|---------------------|---------------------------------------|-----------------------|-------------------------------|-----------------|---|--------------------------|
| CH-1 | H-bridge step-up/down | 2.65 ~ 3.2 | Output voltage | Built-in | Synchronous | CPU, DSP I/F |
| CH-2 | Step-down | 1.1 ~ 1.8 | Output voltage | Built-in | Synchronous | CPU, DSP core |
| CH-3 | Step-up | 4.5 ~ 5.2 | Output voltage, duty cycle | Built-in | Synchronous | Motor, audio |
| CH-4 | Step-up | 15.0 ~ 16,5 | Output voltage, duty cycle | Built-in | Asynchronous, with external rectification diode | LCD, CCD |
| CH-5 | Inversion | -9.0 ~ -7.5 | Output voltage, duty cycle | Built-in | Asynchronous, with external rectification diode | LCD, CCD |
| CH-6 | Step-up with constant current control | 5.6 ~ 21.0 | Output voltage, duty cycle | Built-in | Asynchronous, with external rectification diode | Back light LED |
| CH-7 | Step-down | 2.5 ~ 3.2 | Output voltage, | External | Supehronous | Reserved/switchable |
| CH-7 | Step-up | 4.4 ~ 5.1 | duty cycle | External | Synchronous | Reserved/switchable |
| CH-8 | Step-up/pass-through with skip | 3.6 ~ VCC | | Built-in | Synchronous | IC internal power supply |
| LDO-1 | | 2.9 | | | | Sub-CPU I/F |
| LDO-2 | | 2.9 | | | | Sub-CPU core |
| LDO-3 | | 3.1 | | | | Charge backup battery |
| LDO-4 | | 3.1 | | | | USB |
| LDO-5 | | 8.5 ~ 13.5 | Output voltage | | | LCD |

(1) CH-N represents switching regulators. LDO-N represents series regulators.



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ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | | UNIT |
|------------------|--|---|------------------------------|
| | | ROMWR | –0.3 V to 24 V |
| | | MODE7, DIN, CLK, LD, PWR_ON, LDO4_ON, TEST, TLD | -0.3 V to 7 V |
| VI | Input voltage range ⁽²⁾ | VCH2, VCH7, VCC8 | –0.3 V to 6.5 V |
| | | VCC1, VCC2, VCC5, VCC7, VCC_GD | –0.3 V to 6 V |
| | | VCH5 | -10.0 V to 0.3 V |
| | | VCH4, OUT4, VLDO5, VCH6, ICH6, OUT6 | –0.3 V to 24 V |
| | | BOOT11, BOOT12, BOOT2 | -0.3 V to 11 V |
| | | VOS71, DOUT, XRESET, READY | –0.3 V to 7 V |
| Vo | Output voltage range ⁽²⁾ | ROSC | –0.3 V to 6.5 V |
| | | OUT5 | -10.0 V to 5.1 V |
| | | OUT3 | –0.3 V to 6 V ⁽³⁾ |
| | | Others | –0.3 V to 6 V |
| | | VCC1 = OUT11, GND1 = OUT11, OUT12 = VCH1, OUT12 = GND1, OUT3 = VCH3, OUT3 = GND3 | -4.5 A to 4.5 A |
| | Peak current of Power Path | OUT8 = VCH8, OUT8 = GND8 | -3.0 A to 3 A |
| | | VCC2 = OUT2, GND2 = OUT2, OUT4 = VCH4, OUT4 = GND4, VCC5 = OUT5, OUT6 = VCH6, OUT6 = GND6 | -1.5 A to 1.5 A |
| | Voltage difference between two of any GND p | ins (name starts with GND) | –0.5 V to 0.5 V |
| | ESD rating, HBM (Human Body Model) | JEDEC JESD22-A114 | 1.5 kV |
| | ESD rating, CDM (Charged Device Model) | JEDEC JESD22-C101 | 500 V |
| D | Continuous total power dissipation | | See Dissipation Rating Table |
| 「」 | Operating virtual junction temperature range | | -20°C to 150°C |
| Γ _A | Operating ambient temperature range | | -20°C to 85°C |
| Г _{stg} | Storage temperature range | | –65°C to 150°C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to network ground terminal.

(2) All voltage values are with respect to network ground terminal.

(3) For the pulse smaller than 5 ns, Maximum rating is 8.6 V.

DISSIPATION RATINGS

| PACKAGE ⁽¹⁾ | POWER RATING | DERATING FACTOR | POWER RATING |
|--------------------------|-----------------------|-----------------------------|-----------------------|
| | T _A < 25°C | ABOVE T _A = 25°C | T _A = 70°C |
| nFBGA 113 ⁽²⁾ | 2.99 W | 23.9 mW/°C | 1.95 W |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.

(2) This data is based on using still air JEDEC environment with 2S2P JEDEC board.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | NOM MAX | UNIT |
|---------------------------------|---|--|------|----------|-------|
| V (1) | Supply voltage | VCC_GD | 4.5 | 5.5 | V |
| V _{CC} ⁽¹⁾ | Supply voltage | VCC1, VCC2, VCC5, VCC7, VCC8 | 1.5 | 5.5 | v |
| | | TLD,VCH2,VCH7 | 0 | 5.5 | |
| Vi | Input voltage | MODE7, DIN, CLK, LD, PWR_ON, LDO4_ON, TEST | 0 | 3.3 | V |
| • | | VCH5 | -9.5 | 0.0 | |
| | | ROMWR | 0 | 0.3 | |
| V _{IH1} ⁽²⁾ | High-level input voltage | ILDO1 = 0 mA | 2.4 | 2.9 | V |
| V _{IL1} ⁽²⁾ | Low-level logic input voltage | ILDO1 = 0 mA | 0 | 0.5 | V |
| V _{IH2} | TLD high-level logic input voltage | Ratio to VCC1A voltage | 80% | 100 % | |
| V _{IL2} | TLD low- level logic input voltage | | 0% | 20% | |
| | Voltage difference between two of any 0 | GND pins (name starts with GND) | -0.3 | 0.3 | V |
| T _A | Operating free-air temperature, | | -20 | 85 | °C |
| | Acceptable number of EEPROM writing | (3) | | 20 | Times |

(1) These values are defined in stable state. During the start-up, supply voltage sources are OK to be lower than these values.

(2) Logic input pins are PWR_ON, USB ON, DIN, CLK, LD, TEST, and MODE7, except TLD.

(3) This defines the number of customer's writing after TI's shipment.

ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}$ C, VCC1 = 3.6 V, VCC2 = 3.6 V, VCC5 = 4.9 V, VCC7 = 4.9 V, VCC8 = 3.6 V, VCH8 = 3.6 V, VCH3 = 4.9 V, VCH_GD = 4.9 V, LDO4_ON = L, and all register bits are default value (unless otherwise noted).

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|--|---|--|-------|-------|------|
| SUPPLY CL | IRRENT | | 3.322 3.4 3.478 3.234 3.3 3.366 2.115 2.184 2.253 1.844 1.884 1.924 250 500 0.1 150 300 0.1 0.842 0.85 0.858 | | | |
| ICC1 | | | | | | |
| ICC CTRL | Supply current for controller | PWR_ON = H, No load current at all outputs (see | | | 2.2 | mA |
| IVCC GD | Supply current for gate-drive | Table 1) | | | 5 | mA |
| ICC2A | | | | | | |
| IVCH8 | Supply current for LDO, control | | | | 40 | μA |
| IVCC8 | Supply current for CH-8 | PWR_ON = L (see Table 2) | | | 1 | μA |
| SUB-CPU C | ONTROL | | | | | |
| VRDY1 | READY threshold, rising edge | | 3.322 | 3.4 | 3.478 | V |
| VRDY2 | READY threshold, falling edge | - Sweep VCH8 | 3.234 | 3.3 | 3.366 | v |
| VRST1 | XRESET threshold, rising edge | Sweep VLDO2 | 2.115 | 2.184 | 2.253 | V |
| VRST2 | XRESET threshold, falling edge | Sweep VLDO2 | 1.844 | 1.884 | 1.924 | v |
| IREADY | Sink current of READY | VREADY = 0.5 V | 250 | 500 | | μA |
| l _{ikg} | Leakage current of READY | VREADY = 5.25 V, VCH8 = 5.25 V | | | 0.1 | μA |
| IRST | Sink current of XRESET | VXRESET = 0.5 V, VLDO2 = 2 V | 150 | 300 | | μA |
| IRSTL | Leakage current of XRESET | VXRESET = 5.25 V, VCH8 = 5.25 V | | | 0.1 | μA |
| REFERENC | E AND PROTECTION | | | | | |
| V _{REF} | BG reference voltage, sensed at CBG | I _{REF} = 0 mA | 0.842 | 0.85 | 0.858 | V |
| ΔVIoBG | Load regulation of BG reference voltage buffer | I _{REF} = 0.1 μA ~ 1 mA | -5 | | 5 | mV |
| fosc | Oscillator frequency | ROSC = 150 kΩ | 475 | 500 | 525 | kHz |
| | Temperature threshold to shutdown ⁽¹⁾ | | 140 | 155 | 170 | °C |

ELECTRICAL CHARACTERISTICS (continued)

 $\mathsf{T_A} = 25^\circ \mathsf{C}, \ \mathsf{VCC1} = 3.6 \ \mathsf{V}, \ \mathsf{VCC2} = 3.6 \ \mathsf{V}, \ \mathsf{VCC5} = 4.9 \ \mathsf{V}, \ \mathsf{VCC7} = 4.9 \ \mathsf{V}, \ \mathsf{VCC8} = 3.6 \ \mathsf{V}, \ \mathsf{VCH8} = 3.6 \ \mathsf{V}, \ \mathsf{VCH3} = 4.9 \ \mathsf{V}, \ \mathsf{VC1} = 4.9 \$ VCH_GD = 4.9 V, LDO4_ON = L, and all register bits are default value (unless otherwise noted) .

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------------|---------------------------------------|--|-------|-------|--|------|
| SOFT-STA | RT | 1 | | | | |
| | Source current of SS_SYNC | VSS_SYNC = 0.5 V | 0.7 | 1 | 1.3 | μA |
| | Source current of SS2 | VSS2 = 0.5 V | 0.7 | 1 | 1.3 | μA |
| | Source current of SS3 | VSS3 = 0.5 V | 0.7 | 1 | 1.3 | μA |
| I _{SS} | Source current of SS5 | VSS5 = 0.5 V | 0.7 | 1 | 1.3 | μA |
| | Source current of SS6 | VSS6 = 0.5 V | 0.7 | 1 | 1.3 | μA |
| | Source current of SSLDO5 | VSSLDO5 = 0.5 V | 0.35 | | 0.65 | μA |
| VSS30K | SS3OK threshold voltage | | 1.2 | 1.6 | 2 | V |
| LOGIC INP | UT/OUTPUT | | | | | |
| V _{OH} ⁽²⁾ | High-level logic output voltage | | 2.5 | | | |
| V _{OL} ⁽²⁾ | Low-level logic output voltage | ILDO1 = 0 mA, IDOUT = -0.5 mA | | | 0.4 | V |
| START-UP | CIRCUIT | | | | | |
| VWU | Wake-up voltage | Monitoring VCC8 | | | 1.6 | V |
| CH-1 | | | I | | | |
| | | Vout1 = 0000(bin), T _A = −10 ~ 65°C | 2.744 | 2.8 | 2.856 | V |
| | | Vout1 = 0001(bin), T _A = -10 ~ 65°C | 2.695 | 2.75 | 2.805 | V |
| | | Vout1 = 0010(bin), T _A = −10 ~ 65°C | 2.646 | 2.7 | 2.754 | V |
| | | Vout1 = 0001(bin), T _A = -10 ~ 65°C | 2.597 | 2.65 | 2.703 | V |
| | | Vout1 = 0100(bin), T _A = -10 ~ 65°C | 2.548 | 2.6 | 2.652 | V |
| | | Vout1 = 0101(bin), T _A = -10 ~ 65°C | 2.499 | 2.55 | 2.601 | V |
| | | Vout1 = 0110(bin), T _A = −10 ~ 65°C | 2.450 | 2.5 | 2.550 | V |
| | | Vout1 = 0111(bin), T _A = -10 ~ 65°C | 3.138 | 3.2 | 1.3 1.3 0.65 2 1 0.4 1.6 2.856 2.805 2.754 2.754 2.703 2.652 2.601 2.550 3.264 3.213 3.162 3.213 3.162 3.213 3.162 3.213 3.264 3.213 3.264 3.213 3.265 2.850 2.850 3.264 3.213 3.162 3.213 3.162 3.213 3.162 3.213 3.162 3.213 3.265 2.855 2.855 2.855 2.855 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 2.805 3.264 3.213 3.162 3.111 3.060 3.009 2.958 2.856 2.88 1.2 2.856 2.85 2.856 2.88 2.85 2.856 2.828 2.856 2.828 2.856 2.828 2.855 2.855 2.907 2.856 2.855 2.855 2.907 2.855 2.855 2.855 2.907 2.856 2.855 2.855 2.855 3.264 3.213 3.009 2.958 2.856 2.855 2.855 2.855 3.264 3.213 3.009 2.9558 2.855 2.8 | V |
| VCH1 | Error amp center voltage | Vout1 = 1000(bin), T _A = −10 ~ 65°C | 3.087 | 3.15 | 3.213 | V |
| | | Vout1 = 1001(bin), T _A = -10 ~ 65°C | 3.038 | 3.1 | 3.162 | V |
| | | Vout1 = 1010(bin), T _A = -10 ~ 65°C | 2.989 | 3.05 | 3.111 | V |
| | | Vout1 = 1011(bin), T _A = -10 ~ 65°C | 2.940 | 3 | 3.060 | V |
| | | Vout1 = 1100(bin), T _A = -10 ~ 65°C | 2.891 | 2.95 | 3.009 | V |
| | | Vout1 = 1101(bin), T _A = −10 ~ 65°C | 2.842 | 2.9 | 2.958 | V |
| | | Vout1 = 1110(bin), T _A = -10 ~ 65°C | 2.793 | 2.85 | 2.907 | V |
| | | Vout1 = 1111(bin), T _A = −10 ~ 65°C | 2.769 | 2.825 | 2.88 | V |
| gm1 | gm value of error amp | | 0.8 | 1 | 1.2 | mS |
| VOCH1 ⁽³⁾ | Output voltage | On EVM, T _A = -10 ~ 65°C | 2.744 | 2.8 | 2.856 | V |
| ∆VIi11 ⁽³⁾ | Line regulation (CROSS state) | On EVM | -28 | | 28 | mV |
| ΔVIi12 ⁽³⁾ | Line regulation (DOWN state) | On EVM | -28 | | 28 | mV |
| ΔVIo11 ⁽³⁾ | Load regulation (CROSS state) | On EVM | -28 | | 28 | mV |
| ΔVIo12 ⁽³⁾ | Load regulation (DOWN state) | On EVM | -28 | | 28 | mV |
| IOUT1 ⁽³⁾ | Minimum Load current | On EVM, VCC1=1.8 V | 400 | | | mA |
| VSCP1 | SCP detector threshold | Ratio to VCH1 | 75% | 80% | 85% | |
| Vmod11 | Mode selector threshold, rising edge | Ratio to VCH1 | 130% | 135% | 137% | |
| Vmod12 | Mode selector threshold, falling edge | Ratio to VCH1 | 120% | 125% | 127% | |

Logic output pin is DOUT. Not production tested. Assured by design. Using reference EVM. (2) (3)

ELECTRICAL CHARACTERISTICS (continued)

 $T_A = 25^{\circ}C, VCC1 = 3.6 \text{ V}, VCC2 = 3.6 \text{ V}, VCC5 = 4.9 \text{ V}, VCC7 = 4.9 \text{ V}, VCC8 = 3.6 \text{ V}, VCH8 = 3.6 \text{ V}, VCH3 = 4.9 \text{ V}, VCH_GD = 4.9 \text{ V}, LDO4_ON = L, and all register bits are default value (unless otherwise noted) .$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNI |
|--|---|---|-------------|-------|-------------------------|--------|
| CH-2 | | | | | | |
| | | Vout2 = 0000(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.176 | 1.2 | | V |
| | | | 1.127 | 1.15 | | V |
| | | Vout2 = 0010(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.078 | 1.1 | 1.122 | V |
| CH-2 Voul2 = 0000(bin), T _A = -10 - 65 Voul2 = 0001(bin), T _A = -10 - 65 Voul2 = 0001(bin), T _A = -10 - 65 Voul2 = 0010(bin), T _A = -10 - 65 Voul2 = 0010(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 0101(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1111(bin), T _A = -10 - 65 Voul2 = 1110(bin), T _A = -10 - 65 Voul2 = 1010(bin), T _A = -10 - 65 VOVP2 SCP detector threshold Ratio to VCH2 VOVP2 SCP detector threshold Ratio to VCH2 VOVP2 VPV detector threshold Ratio to VCH2 VOVP2 VPV detector threshold Ratio to VCH2 Vo | Vout2 = 0011(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.764 | 1.8 | 1.836 | V | |
| | | Vout2 = 0100(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.715 | 1.75 | 1.224 1.173 1.122 | V |
| | | Vout2 = 0101(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.666 | 1.7 | 1.734 | V |
| | | Vout2 = 0110(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.617 | 1.65 | 1.683 | V |
| | Error amp contor voltago | Vout2 = 0111(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.568 | 1.6 | 1.632 | V |
| VONZ | Endramp center voltage | Vout2 = 1000(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.519 | 1.55 | 1.581 | V |
| | | Vout2 = 0001(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.470 | 1.5 | 1.530 | V |
| | | Vout2 = 1010(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.421 | 1.45 | 1.479 | V |
| | | Vout2 = 1011(bin), T _A = -10 ~ 65°C | 1.372 | 1.4 | 1.428 | V |
| | | Vout2 = 1100(bin), T _A = -10 ~ 65°C | 1.323 | 1.35 | 1.377 | V |
| | | Vout2 = 1101(bin), T _A = -10 ~ 65°C | 1.274 | 1.3 | 1.326 | V |
| | | Vout2 = 1110(bin), T _A = −10 ~ 65°C | 1.225 | 1.25 | 1.275 | V |
| | | Vout2 = 1111(bin), $T_A = -10 \sim 65^{\circ}C$ | 1.201 | 1.225 | | V |
| gm2 | gm value of error amp | | 0.8 | 1 | | mS |
| - | | On EVM, T _A = -10 ~ 65°C | 1.176 | 1.2 | | V |
| | | | -12 | | | m∖ |
| | 5 | | -12 | | | m\ |
| | | | 500 | | | mA |
| | | | 75% | 80% | 85% | |
| | | | 115% | 120% | | |
| | | | 110,0 | .2070 | 0/0 | |
| - | | Vout1 = 0000(bin), T _A = -10 ~ 65°C | 4.802 | 4.9 | 4.998 | V |
| | | | 4.753 | 4.85 | | V |
| | | | 4.704 | 4.8 | | V |
| | | | 4.655 | 4.75 | | v |
| | | | 4.606 | 4.7 | | v |
| | | | 4.557 | 4.65 | | V |
| | | | 4.508 | 4.05 | | V |
| | | | 4.308 | 4.0 | | V |
| VCH3 | Error amp center voltage | | · · · · · · | | | V |
| | | | 4.410 | 4.5 | | V V |
| | | | 5.096 | 5.2 | | |
| | | | 5.047 | 5.15 | | V |
| | | | 4.998 | 5.10 | | V |
| | | | 4.949 | 5.05 | | V |
| | | Vout1 = 1101(bin), $T_A = -10 \sim 65^{\circ}C$ | 4.900 | 5 | | V |
| | | Vout1 = 1110(bin), $T_A = -10 \sim 65^{\circ}C$ | 4.851 | 4.95 | | V |
| | | Vout1 = 1111(bin), $T_A = -10 \sim 65^{\circ}C$ | 4.802 | 4.9 | | V |
| | 5 | | 0.8 | 1 | | mS |
| | | | 4.802 | 4.90 | | V |
| | Line regulation | | -49 | | 49 | m\ |
| ∆VIo3 ⁽⁴⁾ | Load regulation | On EVM | -49 | | 49 | m\ |
| IOUT3 ⁽⁴⁾ | Minimum Load current | On EVM, [CH-3 input voltage]=1.8 V | 500 | | | mA |
| VSCP3 | SCP detector threshold | Ratio to VCH3 | 75% | 80% | 85% | |
| VOVP3 | OVP detector threshold | Ratio to VCH3 | | 5.99 | | V |

(4) Not production tested. Assured by design. Using reference EVM.

ELECTRICAL CHARACTERISTICS (continued)

 $T_A = 25^{\circ}C, VCC1 = 3.6 \text{ V}, VCC2 = 3.6 \text{ V}, VCC5 = 4.9 \text{ V}, VCC7 = 4.9 \text{ V}, VCC8 = 3.6 \text{ V}, VCH8 = 3.6 \text{ V}, VCH3 = 4.9 \text{ V}, VCH_GD = 4.9 \text{ V}, LDO4_ON = L, and all register bits are default value (unless otherwise noted) .$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------------|-------------------------------------|---|--------|-------|--------|------|
| CH-4 | | | | | | |
| | | Vout4 = 00(bin), $T_A = -10 \sim 65^{\circ}C$ | 14.700 | 15 | 15.300 | V |
| VOUA | F | Vout4 = 01(bin), $T_A = -10 \sim 65^{\circ}C$ | 15.190 | 15.5 | 15.810 | V |
| VCH4 | Error amp center voltage | Vout4 = 10(bin), $T_A = -10 \sim 65^{\circ}C$ | 15.680 | 16 | 16.320 | V |
| | | Vout4 = 11(bin), $T_A = -10 \sim 65^{\circ}C$ | 16.170 | 16.5 | 16.830 | V |
| gm4 | gm value of error amp | | 0.8 | 1 | 1.2 | mS |
| VoCH4 ⁽⁴⁾ | Output voltage | On EVM, T _A = -10 ~ 65°C | 14.700 | 15.0 | 15.300 | V |
| $\Delta VIi4^{(4)}$ | Line regulation | On EVM | -150 | | 150 | mV |
| $\Delta Vlo4^{(4)}$ | Load regulation | On EVM | -150 | | 150 | mV |
| IOUT4 ⁽⁴⁾ | Minimum Load current | On EVM, [CH-4 input voltage] = 1.8 V | 50 | | | mA |
| VSCP4 | SCP detector threshold | Ratio to VCH4 | 75% | 80% | 85% | |
| CH-5 | | | | | | |
| | | Vout5=00(bin), T _A = -10 ~ 65°C | -7.650 | -7.5 | -7.350 | V |
| | | Vout5=01(bin), T _A = -10 ~ 65°C | -8.160 | -8.0 | -7.840 | V |
| VCH5 | Error amp center voltage | Vout5=10(bin), T _A = -10 ~ 65°C | -8670 | -8.5 | -8.330 | V |
| | | Vout5=11(bin), T _A = -10 ~ 65°C | -9.180 | -9.0 | -8.820 | V |
| gm5 | gm value of error amp | | 0.8 | 1.0 | 1.2 | mS |
| VoCH5 ⁽⁵⁾ | Output voltage | On EVM, T _A = -10 ~ 65°C | -7.650 | -7.5 | -7.350 | V |
| $\Delta VIi5^{(5)}$ | Line regulation | On EVM | -75 | | 75 | mV |
| $\Delta VIo5^{(5)}$ | Load regulation | On EVM | -75 | | 75 | mV |
| IOUT5 ⁽⁵⁾ | Minimum Load current | On EVM,VCC5 = 4.9 V | 50 | | | mA |
| VSCP5 | SCP detector threshold | | 75% | 80% | 85% | |
| CH-6 | | | | | | |
| | | Vout5 = 00(bin), $T_A = -10 \sim 65^{\circ}C$ | 0.2482 | 0.264 | 0.2798 | V |
| VFB6 | Error amp center voltage | Vout5 = 01(bin), $T_A = -10 \sim 65^{\circ}C$ | 0.4136 | 0.440 | 0.4664 | V |
| | | Vout5 = 10(bin), $T_A = -10 \sim 65^{\circ}C$ | 0.1654 | 0.176 | 0.1866 | V |
| gm6 | gm value of error amp | | 0.8 | 1 | 1.2 | mS |
| ICH6 ⁽⁵⁾ | Output voltage | On EVM, T _A = -10 ~ 65°C | 11.28 | 12 | 12.72 | mA |
| $\Delta VIi6^{(5)}$ | Line regulation of VFB6 | On EVM | -120 | | 120 | μΑ |
| VOCP | OCP detector threshold | Monitor at FB6 | 0.80 | 0.85 | 0.90 | V |
| VOVP6 | OVP detector threshold | | 21.0 | 22 | 23.0 | V |
| VREF6L | CH-6 disable threshold, low side | | 0.16 | 0.21 | 0.26 | V |
| VREF6H | CH-6 disable threshold, high side | VCH1 = 2.8 V | 1.7 | 2 | 2.3 | V |
| VfDI6 | Forward voltage of integrated diode | I(OUT6 = VCH6) = 20 mA | | | 0.9 | V |

(5) Not production tested. Assured by design. Using reference EVM.

ELECTRICAL CHARACTERISTICS (continued)

 $T_A = 25^{\circ}C$, VCC1 = 3.6 V, VCC2 = 3.6 V, VCC5 = 4.9 V, VCC7 = 4.9 V, VCC8 = 3.6 V, VCH8 = 3.6 V, VCH3 = 4.9 V, VCH_GD = 4.9 V, LDO4_ON = L, and all register bits are default value (unless otherwise noted).

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|--------------------------|---|-------------|------|--|------|
| CH-7 | | | - | | | |
| | | Vout7 = 0000(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.802 | 4.9 | 4.998 | V |
| | | Vout7 = 0001(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.753 | 4.85 | 4.947 | V |
| | | Vout7 = 0010(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.704 | 4.8 | 4.896 | V |
| | | Vout7 = 0001(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.655 | 4.75 | 4.845 | V |
| | | Vout7 = 0100(bin), T _A = -10 ~ 65°C, MODE7 = H | 4.606 | 4.7 | 4.794 | V |
| | | Vout7 = 0101(bin), T _A = -10 ~ 65°C, MODE7 = H | 4.557 | 4.65 | 4.743 | V |
| | | Vout7 = 0110(bin), T _A = -10 ~ 65°C, MODE7 = H | 4.508 | 4.60 | 4.692 | V |
| | | Vout7 = 0111(bin), T _A = -10 ~ 65°C, MODE7 = H | 4.459 | 4.55 | 4.641 | V |
| VCH7U | Error amp center voltage | Vout7 = 1000(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.41 | 4.50 | 4.590 | V |
| | | Vout7 = 1001(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.361 | 4.45 | | V |
| | | Vout7 = 1010(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.312 | 4.40 | | V |
| | | Vout7 = 1011(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.998 | 5.10 | | V |
| | | Vout7 = 1100(bin), $T_A = -10 \sim 65^{\circ}$ C, MODE7 = H | 4.949 | 5.05 | | V |
| | | | | | | V |
| | | Vout7 = 1101(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.9 | 5 | | |
| | | Vout7 = 1110(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = H | 4.851 | 4.95 | 4.998 4.947 4.896 4.845 4.794 4.743 4.692 4.641 4.590 4.539 4.488 5.202 5.151 5.1 5.141 3.049 4.998 3.162 3.111 3.060 3.009 2.958 2.907 2.856 2.703 2.652 2.601 2.550 3.264 3.213 3.162 1.2 4.998 49 49 49 49 49 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 3.162 | V |
| | | Vout7 = 1111(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 4.802 | 4.90 | | V |
| | | Vout7 = 0000(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 3.038 | 3.1 | | V |
| | | Vout7 = 0001(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.989 | 3.05 | | V |
| | | Vout7 = 0010(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.940 | 3.00 | 3.060 | V |
| | | Vout7 = 0001(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.891 | 2.95 | 3.009 | V |
| | | Vout7 = 0100(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.842 | 2.9 | 2.958 | V |
| | | Vout7 = 0101(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.793 | 2.85 | 2.907 | V |
| | | Vout7 = 0110(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.744 | 2.8 | 2.856 | V |
| | | Vout7 = 0111(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 2.695 | 2.75 | 2.805 | V |
| VCH7D | Error amp center voltage | Vout7 = 1000(bin), T _A = -10 ~ 65°C, MODE7 = L | 2.646 | 2.7 | 2.754 | V |
| | | Vout7 = 1001(bin), T _A = -10 ~ 65°C, MODE7 = L | 2.597 | 2.65 | 2.703 | V |
| | | Vout7 = 1010(bin), T _A = -10 ~ 65°C, MODE7 = L | 2.548 | 2.6 | 2.652 | V |
| | | Vout7 = 1011(bin), T _A = -10 ~ 65°C, MODE7 = L | 2.499 | 2.55 | 2.601 | V |
| | | Vout7 = 1100(bin), T _A = -10 ~ 65°C, MODE7 = L | 2.450 | 2.5 | 4.947 4.896 4.845 4.794 4.743 4.692 4.641 4.590 4.539 4.488 5.202 5.151 5.1 5.1 5.049 4.998 3.162 3.111 3.060 3.009 2.958 2.907 2.856 2.805 2.754 2.805 2.754 2.805 2.754 2.805 2.754 2.805 2.754 3.2652 2.601 2.550 3.264 3.213 3.162 1.2 4.998 49 49 49 49 49 3.162 3.265 3. | V |
| | | Vout7 = 1101(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 3.138 | 3.2 | | V |
| | | Vout7 = 1110(bin), $T_A = -10 \sim 65^{\circ}$ C, MODE7 = L | 3.087 | 3.15 | | V |
| | | Vout7 = 1111(bin), $T_A = -10 \sim 65^{\circ}C$, MODE7 = L | 3.038 | 3.1 | | V |
| gm7 | gm value of error amp | | 0.8 | 1 | | mS |
| √oC71 ⁽⁶⁾ | Output voltage | Mode7 = H, On EVM, T _A = -10 ~ 65°C | 4.802 | 4.9 | | V |
| VIi71 ⁽⁶⁾ | Line regulation | Mode7 = H, On EVM | -49 | 7.3 | | mV |
| 2VII/1 ⁽⁶⁾ | | Mode7 = H, On EVM | -49 | | | mV |
| OUT71 ⁽⁶⁾ | Load regulation | | · · · · · · | | 49 | |
| | Minimum Load current | Mode7 = H, On EVM, VCC7=1.8 V | 500 | 0.4 | 0.400 | mA |
| VOCH72 ⁽⁶⁾ | Output voltage | Mode7 = L, On EVM, $T_A = -10 \sim 65^{\circ}C$ | 3.038 | 3.1 | | V |
| 4VIi72 ⁽⁶⁾ | Line regulation | Mode7 = L, On EVM | -31 | | | mV |
| 1VI072 ⁽⁶⁾ | Load regulation | Mode7 = L, On EVM | -31 | | 31 | mV |
| OUT72 ⁽⁶⁾ | Minimum load current | Mode7 = L, On EVM, [CH-7 input voltage] = 4.9 V | 150 | | | mA |
| /SCP7 | SCP detector threshold | Ratio to VCH7 | 75% | 80% | 85% | |
| /OVP7 | OVP detector threshold | Ratio to VCH7 | | 5.99 | | V |
| OS71H | Source current of OS71 | VOS71 = 0 V, VCH3 = VCH7 = 4.9 V | | | -6 | mA |
| OS71L | Sink current of OS71 | VOS71 = 4.9 V, VCH3 = VCH7 = 4.9 V | 0.2 | | | μA |
| OS72H | Source current of OS72 | VOS72 = 4.4 V, VCH3 = VCH7 = 4.9 V | | | -100 | mA |
| IOS72L | Sink current of OS72 | VOS72 = 0.5 V, VCH3 = VCH7 = 4.9 V | 100 | | | mA |

(6) Not production tested. Assured by design. Using reference EVM.



ELECTRICAL CHARACTERISTICS (continued)

 $T_A = 25^{\circ}C, VCC1 = 3.6 \text{ V}, VCC2 = 3.6 \text{ V}, VCC5 = 4.9 \text{ V}, VCC7 = 4.9 \text{ V}, VCC8 = 3.6 \text{ V}, VCH8 = 3.6 \text{ V}, VCH3 = 4.9 \text{ V}, VCH_GD = 4.9 \text{ V}, LDO4_ON = L, and all register bits are default value (unless otherwise noted) .$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|--------------------------------------|--|-------|-----|-------|------|
| IOS73H | Source current of OS73 | VOS73 = 0.0 V, VCH3 = VCH7 = 4.9 V | · · · | | -100 | mA |
| IOS73L | Sink current of OS73 | VOS73 = 0.5 V, VCH3 = VCH7 = 4.9 V | 100 | | | mA |
| ROS71n | ON resistance | NMOS (OS71, GND GD), VOS71 = 0.1 V, VCH3 = VCH7 = 4.9 V | | | 7.5 | kΩ |
| ROS72n | ON resistance | NMOS(OS72, GND GD), VOS72 = 0.1 V, VCH3 = VCH7 = 4.9 V | | | 5 | Ω |
| ROS73n | ON resistance | NMOS(OS73, GND GD), VOS73 = 0.1 V, VCH3 = VCH7 = 4.9 V | | | 5 | Ω |
| ROS71p | ON resistance | PMOS(VCH7, OS71), VOS71 = 4.8 V, VCH3 = VCH7 = 4.9 V | | | 360 | Ω |
| ROS72p | ON resistance | PMOS(VCC7, OS72), VOS72 = 4.8 V, VCH3 = VCH7 = 4.9 V | | | 5 | Ω |
| ROS73p | ON resistance | PMOS(VCC GD, OS73), VOS73 = 4.8 V, VCH3 = VCH7 = 4.9 V | | | 15 | Ω |
| CH-8 | | | · · · | | | |
| VCH81 | Error amp center voltage (normal) | | 3.528 | 3.6 | 3.672 | V |
| VCH82 | Error detector center voltage (skip) | PWR_ON = H, T _A = -10 ~ 65°C | 3.492 | 3.6 | 3.708 | V |
| gm8 | gm value of error amp | | 0.8 | 1 | 1.2 | mS |
| VoCH81 ⁽⁷⁾ | Output voltage (skip) | | 3.492 | 3.6 | 3.708 | V |
| VoCH82 ⁽⁷⁾ | Output voltage (normal) | On EVM, T _A = -10 ~ 65°C, VCC8 = 1.5 ~ 3.6 V | 3.528 | 3.6 | 3.672 | V |
| ΔVIi81 ⁽⁷⁾ | Line regulation (skip) | On EVM, VCC8 = 1.8 ~ 3.6 V (= VoCH81) ⁽⁸⁾ | -108 | | 180 | mV |
| ΔVIi82 ⁽⁷⁾ | Line regulation (normal) | On EVM, VCC8 = 1.8 ~ 3.6 V | -36 | | 36 | mV |
| ΔVIo81 ⁽⁷⁾ | Load regulation (skip) | On EVM, VCC8 = 1.8 ~ 3.6 V, ICH8 < x[mA] | -120 | | 120 | mV |
| ΔVIo82 ⁽⁷⁾ | Load regulation (normal) | On EVM, VCC8 = 1.8 ~ 3.6 V | -36 | | 36 | mV |
| IOUT81 ⁽⁷⁾ | Minimum Load current (skip) | On EVM, VCC8 = 1.8 V | 120 | | | mA |
| IOUT82 ⁽⁷⁾ | Minimum Load current (normal) | On EVM, VCC8 = 1.8 V | 170 | | | mA |

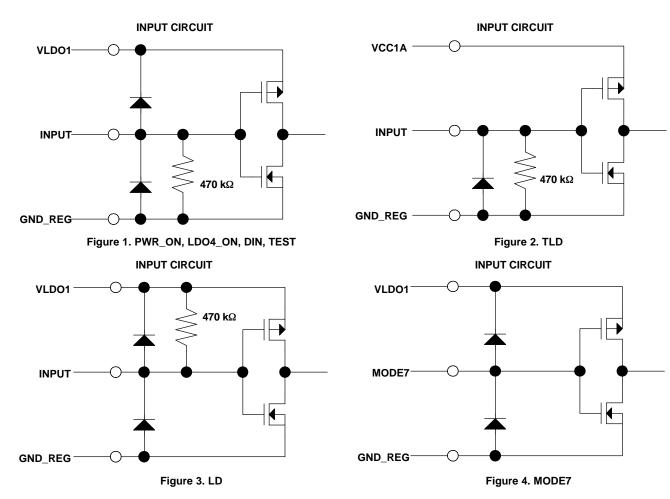
(7) Not production tested. Assured by design. Using reference EVM.

(8) This parameter Δ Vli81 is covered by VoCH81 and adjusted to VoCH81.

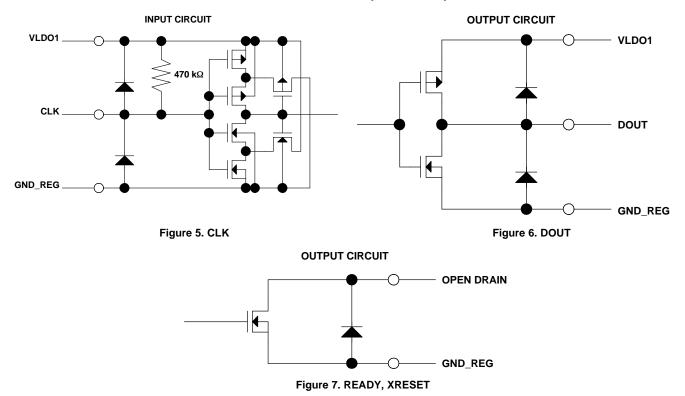
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------|----------------------|------------------------------------|-------|-------|-------|------|
| LDO-1 | | | | | | |
| VLDO1 | Output voltage | VCH8 = 3.6 ~ 5.25 V, ILDO1 = 5 mA | 2.842 | 2.9 | 2.958 | V |
| ΔVIiL1 | Line regulation | VCH8 = 3.6 ~ 5.25 V, ILDO1 = 5 mA | | | 30 | mV |
| Δ VloL1 | Load regulation | VCH8 = 3.6 V, ILOD1 = 0.1 ~ 30 mA | | | 100 | mV |
| | Output current limit | VCH8 = 3.6 ~ 5.25 V | 36 | | | mA |
| LDO-2 | | | | | | |
| VLDO2 | Output voltage | VCH8 = 3.6 ~ 5.25 V, ILDO2 =6 mA | 2.842 | 2.9 | 2.958 | V |
| $\Delta VIiL2$ | Line regulation | VCH8 = 3.6 ~ 5.25 V, ILDO2 = 6 mA | | | 30 | mV |
| $\Delta VIoL2$ | Load regulation | VCH8 = 3.6 V, ILOD2 = 0.1 ~ 50 mA | | | 100 | mV |
| | Output current limit | VCH8 = 3.6 ~ 5.25 V | 60 | | | mA |
| LDO-3 | | | | | | |
| VLDO3 | Output voltage | VCH8 = 3.6 ~ 5.25 V, ILDO3 = 10 mA | 3.038 | 3.1 | 3.162 | V |
| ΔVIiL3 | Line regulation | VCH8 = 3.6 ~ 5.25 V, ILDO3 = 10 mA | | | 30 | mV |
| Δ VloL3 | Load regulation | VCH8 = 3.6 V, ILOD3 = 0.1 ~ 20 mA | | | 100 | mV |
| | Output current limit | VCH8 = 3.6 ~ 5.25 V | 24 | | | mA |
| LDO-4 | | | | | | |
| VLDO4 | Output voltage | VCH8 = 3.6 ~ 5.25 V, ILDO4 = 5 mA | 3.078 | 3.142 | 3.202 | V |
| ∆VIiL4 | Line regulation | VCH8 = 3.6 ~ 5.25 V, ILDO4 = 5 mA | | | 30 | mV |
| Δ VloL4 | Load regulation | VCH8 = 3.6 V, ILOD1 = 0.5 ~ 100 mA | | | 100 | mV |
| | Output current limit | VCH8 = 3.6 ~ 5.25 V | 120 | | | mA |

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------|----------------------|--|---|-------|---------------|------|
| LDO-5 | | | | | | |
| | | LDO5Vo = 00 (bin), $T_A = -10 \sim 65^{\circ}C$, ILDO5 = 15 mA | 13.23 | 13.5 | 13.778 | |
| | | LDO5Vo = 01 (bin), $T_A = -10 \sim 65^{\circ}C$, ILDO5 = 15 mA | 12.25 | 12.5 | 12.75 | |
| VLDO5 | Output voltage | LDO5Vo = 10 (bin), $T_A = -10 \sim 65^{\circ}C$, ILDO5 = 15 mA | = 10 (bin), $T_A = -10 \sim 65^{\circ}C$, 11.76 12 | 12.24 | V | |
| | | LDO5Vo = 11 (bin), $T_A = -10 \sim 65^{\circ}C$, ILDO5 = 15 mA | 8.33 | 8.5 | 12.24 8.67 | |
| Δ VliL5 | Line regulation | VCH4 = 15 ~ 16.5 V, ILDO5 = 5 mA | | | 50 | mV |
| $\Delta VIoL5$ | Load regulation | VCH4 = 15 V, ILOD5 = 0.1 ~ 15 mA | | | 50 | mV |
| | Output current limit | VCH4 = 15 ~ 16.5 V | 36 | | | mA |

EQUIVALENT INPUT/OUTPUT CIRCUIT DIAGRAMS



EQUIVALENT INPUT/OUTPUT CIRCUIT DIAGRAMS (continued)



ICC1

ICC1 represents the supply current measured when all channels are operating normally with no load. It is difficult to connect coils and other external devices to the TPS65520. Therefore, to measure characteristics in shipping tests, the desired ICC1 is specified using two testable parameters with the pins handled as shown in Table 1.

ICC_CTRL represents the supply current from the 2.9-V and 4.2-V power supplies shown in the tables. ICC_GD represents the supply current from the 4.2-V power supplies shown in the tables. IVCC_GD is a self-consumed gate drive current from CH-3. Therefore, it is associated with the desired ICC1 through the CH-3 efficiency. Equation 1 indicates the relationship between IVCC_GD and the supply current from the power supplies in the application circuit (ICC1). ICC1 is specified as the supply current when a voltage of 4.2 V is the input. ICC_CTRL is the current consumed by the TPS65520 (excluding IVCC_GD).

$$ICC1 = \frac{4.9}{4.2} \times \frac{1}{\eta_{CH-3}} \times IVCC_GD + ICC_CTRL$$

$$\frac{4.3 \times 1000_{-00}}{4.2 \times (ICC1 - ICC_{-}CTRL)} = \eta_{CH-3}$$

(1)

Table 1. Pin Handling for Measuring ICC1

| Pin Name | Connection | Note | | | | | |
|------------|---------------|------------------------------------|--|--|--|--|--|
| POWER SUP | PLY | | | | | | |
| VCC GD | 4.9 V | Supply gate drive | | | | | |
| GND_GD | GND | | | | | | |
| GNDANA | GND | | | | | | |
| GNDLOG | GND | | | | | | |
| GNDREG | GND | | | | | | |
| GNDLDOA | GND | | | | | | |
| SUB-CPU CO | | | | | | | |
| PWR ON | 2.9 V | | | | | | |
| CSCP | GND | avoid shutdown | | | | | |
| ROSC | 150 kΩ to GND | recommended part | | | | | |
| CREF | Сар | recommended part | | | | | |
| CBG | Сар | recommended part | | | | | |
| VLDO1 | Сар | recommended part | | | | | |
| VLDO2 | Сар | recommended part | | | | | |
| VLDO3 | Сар | recommended part | | | | | |
| VLDO4 | Сар | recommended part | | | | | |
| VLDO5 | Сар | recommended part | | | | | |
| LOGIC | υup | | | | | | |
| ROMWR | GND | | | | | | |
| TEST | open | pull down internally | | | | | |
| TLD | open | pull down internally | | | | | |
| CLK | open | pull up internally | | | | | |
| DIN | open | pull down internally | | | | | |
| LD | open | pull up internally | | | | | |
| DOUT | open | (not concerned) | | | | | |
| SS, ETC. | opon | (not concorrica) | | | | | |
| READY | open | (not concerned) | | | | | |
| XRESET | open | (not concerned) | | | | | |
| LDO4_ON | 2.9 V | force LDO-4 ON | | | | | |
| SS_SYNC | open | (not concerned) | | | | | |
| SS2 | open | (not concerned) | | | | | |
| SS3 | open | (not concerned) | | | | | |
| SS5 | open | (not concerned) | | | | | |
| SS6 | open | (not concerned) | | | | | |
| SSLDO5 | open | (not concerned) | | | | | |
| CH-1 | open | (not concerned) | | | | | |
| BOOT11 | 4.9 V | supply gate driver | | | | | |
| BOOT12 | 4.9 V | supply gate driver | | | | | |
| VCH1A/B/C | 2.9 V | force output | | | | | |
| VCC1A/B/C | 2.9 V | supply CH-1 | | | | | |
| GND1A/B/C | GND | | | | | | |
| OUT11A/B/C | open | (not concerned) | | | | | |
| OUT12A/B/C | open | (not concerned) (not concerned) | | | | | |
| ERR1 | 4.2 V | force MAX DUTY | | | | | |
| | 7.2 V | | | | | | |

| or Measuring | g ICC1 | | | | | |
|--------------|------------|--------------------|--|--|--|--|
| Pin Name | Connection | Note | | | | |
| CH-2 | | | | | | |
| BOOT2 | 4.9 V | supply gate driver | | | | |
| VCH2 | GND | force MAX DUTY | | | | |
| VCC2 | 2.9 V | bias power MOS | | | | |
| OUT2 | open | (not concerned) | | | | |
| GND2 | GND | | | | | |
| ERR2 | 4.2 V | force MAX DUTY | | | | |
| CH-3 | | | | | | |
| VCH3A/B/C | 4.9 V | supply TAKUMI | | | | |
| VCH3S | open | (not concerned) | | | | |
| OUT3A/B/C | open | (not concerned) | | | | |
| GND3A/B/C | GND | | | | | |
| ERR3 | 4.2 V | force MAX DUTY | | | | |
| CH-4 | | | | | | |
| VCH4 | 4.9 V | force MAX DUTY | | | | |
| OUT4 | open | (not concerned) | | | | |
| GND4 | GND | | | | | |
| ERR4 | open | (not concerned) | | | | |
| CH-5 | | 1 | | | | |
| VCH5 | GND | force MAX DUTY | | | | |
| VCC5 | 4.9 V | supply gate driver | | | | |
| OUT5 | open | (not concerned) | | | | |
| ERR5 | open | (not concerned) | | | | |
| CH-6 | | 1 | | | | |
| OUT6 | open | (not concerned) | | | | |
| FB6 | GND | force MAX DUTY | | | | |
| VCH6 | open | (not concerned) | | | | |
| ICH6 | open | (not concerned) | | | | |
| GND6 | GND | | | | | |
| REF6 | CBG | bias | | | | |
| ERR6 | open | (not concerned) | | | | |
| CH-7 | | | | | | |
| VCH7 | open | (not concerned) | | | | |
| VCC7 | 4.9 V | supply gate driver | | | | |
| ERR7 | 4.2 V | force MAX DUTY | | | | |
| MODE7 | GND | fix logic value | | | | |
| VOS71 | open | (not concerned) | | | | |
| VOS72 | open | (not concerned) | | | | |
| VOS73 | open | (not concerned) | | | | |
| CH-8 | | | | | | |
| VCH8A/B | 4.2 V | force through mode | | | | |
| VCC8 | 4.2 V | force through mode | | | | |
| ERR8 | 4.2 V | force MAX DUTY | | | | |
| OUT8A/B | open | (not concerned) | | | | |
| GND8A/B | GND | | | | | |



ICC2

ICC2 represents the supply current measured when the system operation is minimized with CH-8 placed in sleep mode. It is difficult to connect coils and other external devices to the TPS65520 to measure its characteristics in shipping tests. Therefore, the desired ICC2 is specified using three testable parameters with the pins handled as shown in Table 2.

IVCC8 and IVCH8 represent the supply currents from the VCC8 and VCH8 pins, respectively.

Equation 2 indicates the relationship between those currents and the supply current from the power supplies in the application circuit (ICC2). ICC2 is specified as the supply current when a voltage of 3.6 V is input.

 $\mathsf{ICC2} = \frac{1}{\eta_{\mathsf{CH}-8:skip}} \times \mathsf{IVCH8} + \mathsf{IVCC8}$

(2)

| Pin Name | Connection | Note | |
|-------------|---------------|----------------------|----|
| POWER SUPPI | Y | | SS |
| VCC_GD | open | (not concerned) | CH |
| GND_GD | GND | | BC |
| GNDANA | GND | | BC |
| GNDLOG | GND | | VC |
| GNDREG | GND | | VC |
| GNDLDOA | GND | | GN |
| LOGIC | | | OL |
| ROMWR | GND | | OL |
| TEST | open | pull down internally | ER |
| TLD | open | pull down internally | CH |
| CLK | open | pull up internally | BC |
| DIN | open | pull down internally | VC |
| LD | open | pull up internally | VC |
| DOUT | open | (not concerned) | OL |
| SUB-CPU CON | TROL | | GN |
| PWR_ON | GND | | ER |
| CSCP | GND | avoid shutdown | CH |
| ROSC | 150 kΩ to GND | recommended part | VC |
| CREF | Сар | recommended part | VC |
| CBG | Сар | recommended part | OL |
| VLDO1 | Сар | recommended part | GN |
| VLDO2 | Сар | recommended part | ER |
| VLDO3 | Сар | recommended part | CH |
| VLDO4 | Сар | recommended part | VC |
| VLDO5 | Сар | recommended part | OL |
| SS, ETC. | 1 | | GN |
| READY | open | (not concerned) | ER |
| XRESET | open | (not concerned) | CH |
| LDO4_ON | GND | | VC |
| SS_SYNC | open | (not concerned) | VC |
| SS2 | open | (not concerned) | OL |
| SS3 | open | (not concerned) | ER |
| SS5 | open | (not concerned) | CH |
| SS6 | open | (not concerned) | OL |

Table 2. Pin Handling for Measuring ICC2

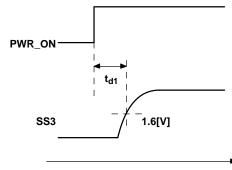
| or Measuring | | | | | | |
|--------------|------------|-----------------|--|--|--|--|
| Pin Name | Connection | Note | | | | |
| SSLDO5 | open | (not concerned) | | | | |
| CH-1 | I | | | | | |
| BOOT11 | open | (not concerned) | | | | |
| BOOT12 | open | (not concerned) | | | | |
| VCH1A/B/C | open | (not concerned) | | | | |
| VCC1A/B/C | open | (not concerned) | | | | |
| GND1A/B/C | GND | | | | | |
| OUT11A/B/C | open | (not concerned) | | | | |
| OUT12A/B/C | open | (not concerned) | | | | |
| ERR1 | open | (not concerned) | | | | |
| CH-2 | | | | | | |
| BOOT2 | open | (not concerned) | | | | |
| VCH2 | open | (not concerned) | | | | |
| VCC2 | open | (not concerned) | | | | |
| OUT2 | open | (not concerned) | | | | |
| GND2 | GND | | | | | |
| ERR2 | open | (not concerned) | | | | |
| CH-3 | | | | | | |
| VCH3A/B/C | open | (not concerned) | | | | |
| VCH3S | open | (not concerned) | | | | |
| OUT3A/B/C | open | (not concerned) | | | | |
| GND3A/B/C | GND | | | | | |
| ERR3 | open | (not concerned) | | | | |
| CH-4 | | | | | | |
| VCH4 | open | (not concerned) | | | | |
| OUT4 | open | (not concerned) | | | | |
| GND4 | GND | | | | | |
| ERR4 | open | (not concerned) | | | | |
| CH-5 | L | | | | | |
| VCH5 | open | (not concerned) | | | | |
| VCC5 | open | (not concerned) | | | | |
| OUT5 | open | (not concerned) | | | | |
| ERR5 | open | (not concerned) | | | | |
| CH-6 | 1 | , | | | | |
| OUT6 | open | (not concerned) | | | | |
| <u> </u> | ı • | . , | | | | |

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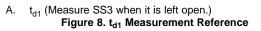
TPS65520

| Pin Name | Connection | Note |
|----------|------------|-----------------|
| FB6 | GND | |
| VCH6 | open | (not concerned) |
| ICH6 | open | (not concerned) |
| GND6 | GND | |
| REF6 | open | (not concerned) |
| ERR6 | open | (not concerned) |
| CH-7 | | |
| VCH7 | open | (not concerned) |
| VCC7 | open | (not concerned) |
| ERR7 | open | (not concerned) |

| Pin Name | Connection | Note | | |
|----------|----------------------|------------------------|--|--|
| MODE7 | GND | fix logic value | | |
| VOS71 | open | (not concerned) | | |
| VOS72 | open | (not concerned) | | |
| VOS73 | open | (not concerned) | | |
| CH-8 | | | | |
| VCH8A/B | 3.7 V | stop skip switching | | |
| VCC8 | 3.6 V | supply to CH-8 circuit | | |
| ERR8 | open | (not concerned) | | |
| OUT8A/B | open (not concerned) | | | |
| GND8A/B | GND | | | |







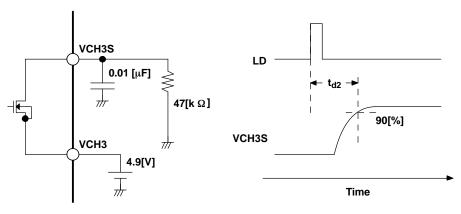
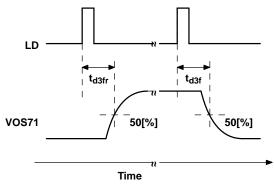


Figure 9. $t_{\rm d2}$ Measuring Circuit and Measurement Reference



A. t_{d3r} , t_{d3f} (Measure VOS71 when it is left open.)



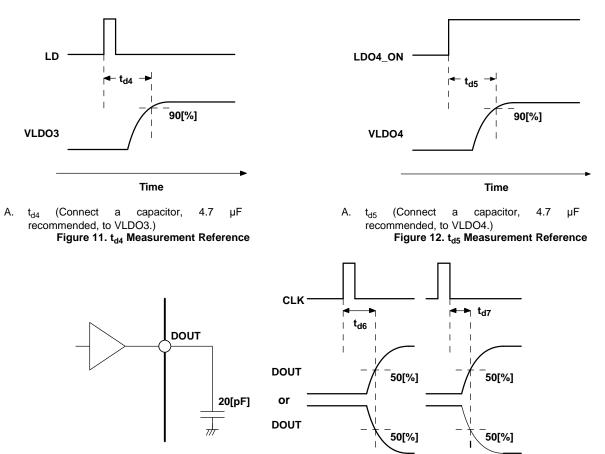


Figure 13. $t_{d6} \, and \, t_{d7}$ Measuring Circuit and Measurement References

Time

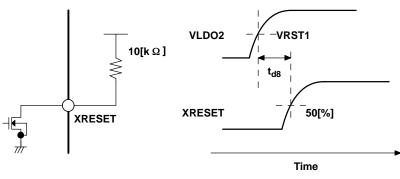


Figure 14. t_{d8} Measuring Circuit and Measurement Reference

TIMING REQUIREMENTS

 $T_A = 25^{\circ}$ C, VCC1 = 3.6 V, VCC2 = 3.6 V, VCC5 = 3.6 V, VCC7 = 3.6 V, VCC8 = 3.6 V, VCH8 = 3.6 V, VCH3 = 4.9 V, VCH_GD = 4.9 V, LDO4_ON = L, and all register bits are default value (unless otherwise noted)

| | PARAMETER | MIN | MAX | UNIT |
|------------------|---|-----|-----|------|
| t _{s1} | Setup time, LD \downarrow before CLK \uparrow (see Figure 33) | 400 | | ns |
| t _{s2} | Setup time, DIN valid before CLK ↑ (see Figure 33) | 200 | | ns |
| t _{s3} | Setup time, TLD \uparrow after CLK \uparrow (see Figure 39) | 50 | | ns |
| t _{s4} | Setup time, TLD \uparrow before CLK \uparrow (see Figure 39) | 50 | | ns |
| t _{s5} | Setup time, ROMWR 1 before TLD1 (see Figure 43) | 10 | | μs |
| t _{h1} | Hold time, DIN valid after CLK \uparrow (see Figure 33) | 50 | | ns |
| t _{h2} | Hold time, LD \uparrow after last CLK \uparrow (see Figure 33) | 50 | | ns |
| t _{h3} | Hold time, ROMWR \downarrow after last TLD \downarrow (see Figure 33) | 10 | | μs |
| t _{w1} | Pulse width of TLD = H for Test0 ~ Test5 (see Figure 39) | 50 | | ns |
| t _{w2} | Pulse width of TLD = H for Test6,Test7 (see Figure 43) | 20 | | ms |
| t _{w3} | Pulse width of CLK = H (see Figure 33) | 100 | | ns |
| t _{cyc} | Period of CLK ↑ (see Figure 33) | 500 | | ns |

SWITCHING CHARACTERISTICS

| | PARAMETER | MIN | TYP | MAX | UNIT |
|------------------|---|-----|-----|------|------|
| t _{d1} | Delay time, PWR_ON \uparrow to start of charging SS3 (see Figure 8 and Figure 30) | | 1.1 | 1.15 | ms |
| t _{d2} | Delay time, LD \uparrow to VCH3S \uparrow (see Figure 9 and Figure 30) | | 500 | 750 | μs |
| t _{d3r} | Delay time, LD \uparrow to VOS71 \uparrow , VCH7 = 4.9 V (see Figure 10 and Figure 30) | | 500 | 1000 | ns |
| t _{d3f} | Delay time, LD \uparrow to VOS71 \downarrow , VCH7 = 4.9 V (see Figure 10 and Figure 30) | | 60 | 100 | μs |
| td4 | Delay time, LD ↑ to VLDO3 ↑ (see Figure 11 and Figure 30) | | 300 | 650 | μs |
| t _{d5} | Delay time, LDO4_ON ↑ to VLDO4 ↑ (see Figure 12 and Figure 30) | | 300 | 650 | μs |
| t _{d6} | Delay time, last CLK \uparrow to DOUT valid for Normal Mode (see Figure 13, Figure 33, and Figure 39) | | 100 | 200 | ns |
| t _{d7} | Delay time, CLK \downarrow to DOUT valid for Test0, Test2, Test3, Test5 (see Figure 13, Figure 33, and Figure 39) | | 100 | 200 | ns |
| t _{d8} | Delay time, VLDO2 exceeds VRST1 to XRESET ↑ (see Figure 14) | 200 | 300 | 600 | μs |

| | (TOP VIEW) | | | | | | | | | | | |
|----|------------|--------|---------|---------|-------|---------|--------|--------------|--------|--------|--------------|------------------|
| 11 | VLD01 | VCC8 | VCH8B | GND8B | VCH2 | GND2 | VCC1A | OUT11A | OUT11C | GND1C | OUT12A | |
| 10 | VLDO3 | GND | VCH8A | GND8A | BOOT2 | OUT2 | VCC1B | OUT11B | GND1B | OUT12B | VCH1A | |
| 9 | GND_LDOA | VLDO2 | NC | OUT8A | OUT8B | VCC2 | VCC1C | GND1A | OUT12C | VCH1B | VCH1C | Voltage Output |
| 8 | CREF | VLDO5 | VLDO4 | NC | NC | SSLDO5 | BOOT11 | BOOT12 | ROMWR | CLK | DIN | Power Line |
| 7 | READY | XRESET | PWR_ON | LDO4_ON | | | | ROMWR | TEST | LD | DOUT | GND Line |
| 6 | ERR1 | ERR2 | ERR8 | ERR8 | | | | TLD | VCH4 | OUT4 | GND4 | MOS Gate Drive |
| 5 | GND_ANA | CBG | SS_SYNC | ERR4 | NC | | | TEST | VCH5 | VCC5 | OUT5 | Logic Line |
| 4 | ERR5 | SS5 | ERR7 | NC | NC | GND_LOG | FB6 | VCH3B | VCC7 | VOS72 | GND_GD | Analog Line |
| 3 | VOS71 | MODE7 | SS6 | GND | NC | GND6 | FB6 | VCH3C | OUT3A | VCH7 | VOS73 | Analog Line(CAP) |
| 2 | SS3 | ERR3 | SS2 | NC | ROSC | GND6 | ICH6 | VCH3S | OUT3C | GND3B | GND3A | |
| 1 | ERR6 | REF6 | GND_REG | GND | CSCP | OUT6 | VCH6 | VCC_GD | VCH3A | OUT3B | GND3C | |
| | Α | В | С | D | Е | F | G | H | J | к | L | |

PIN LAYOUT

Figure 15. Pin Layout

TERMINAL FUNCTIONS

| - | TERMINAL | | | TERMINAL FUNCTIONS |
|-----|----------------|--------------|-----|--|
| NO. | PIN ADDRESS | NAME | I/O | DESCRIPTION |
| 1 | 1-A | ERR6 | 0 | Output of gm amp for CH-6 |
| 2 | 1-B | REF6 | Ю | Reference resistor of CH-6 |
| 3 | 1-C | GND_REG | G | Ground for analog circuit of regulators |
| 4 | 1-D | NC | | No connection (recommended to be GND) |
| 5 | 1-E | CSCP | ю | Current source of short-circuit protection |
| 6 | 1-F | OUT6 | ю | Output side terminal of coil L6 for CH-6 |
| 7 | 1-G | VCH6 | 0 | Output voltage of CH-6 |
| 8 | 1-H | VCC_GD | V | Power supply for gate driver of internal power MOS-FET |
| 9 | 1-J | VCH3A | 0 | Output of CH-3 (1/3) |
| 10 | 1-K | OUT3B | ю | Output side terminal of coil L3 for CH-3 (2/3) |
| 11 | 1-L | GND3C | G | Ground for CH-3 (3/3) |
| 12 | 2-A | SS3 | 0 | Current source of soft-start for CH-3 |
| 13 | 2-B | ERR3 | 0 | Output of gm amp for CH-3 |
| 14 | 2-C | SS2 | I | Current source of soft-start for CH-2 |
| 15 | 2-D | NC | | No connection (recommended to be GND) |
| 16 | 2-E | ROSC | 0 | Reference resistor for PWM oscillator |
| 17 | 2-F(= 3-F) | GND6 | G | Ground for CH-6(same pin as No.28, 3-F) |
| 18 | 2-G | ICH6 | IO | LEDs cathode of CH-6 |
| 19 | 2-H | VCH3S | 0 | Analog switched output of CH-3 |
| 20 | 2-J | OUT3C | Ю | Output side terminal of coil L3 for CH-3 (3/3) |
| 21 | 2-K | GND3B | G | Ground for CH-3 (2/3) |
| 22 | 2-L | GND3A | G | Ground for CH-3 (1/3)n |
| 23 | 3-A | VOS71 | 0 | Gate drive of external PMOS switch for CH-7 |
| 24 | 3-B | MODE7 | I | Mode selection of CH-7 |
| 25 | 3-C | SS6 | 0 | Current source of soft-start for CH-6 |
| 26 | 3-D | NC | | No connection (recommended to be GND) |
| 27 | 3-E | NC | | No connection (recommended to be GND) |
| 28 | 3-F(= 2-F) | GND6 | G | Ground for CH-6 (same pin as No.17, 2-F) |
| 29 | 3-G(= 4-G) | FB6 | Ю | Current sense input of CH-6 (same pin as No.40, 4-G) |
| 30 | 3-H | VCH3C | 0 | Output of CH-3 (3/3) |
| 31 | 3-J | OUT3A | Ю | Output side terminal of coil L3 for CH-3 (1/3) |
| 32 | 3-K | VCH7 | 0 | Output of CH-7 |
| 33 | 3-L | VOS73 | 0 | Gate drive of low side NMOS switch for CH-7 |
| 34 | 4-A | ERR5 | 0 | Output of gm amp for CH-5 |
| 35 | 4-B | SS5 | 0 | Current source of soft-start for CH-5 |
| 36 | 4-C | ERR7 | 0 | Output of gm amp for CH-7 |
| 37 | 4-D | NC | | No connection (recommended to be GND) |
| 38 | 4-E | NC | | No connection (recommended to be GND) |
| 39 | 4-F | GND_LOG | G | Ground for general logic circuit |
| 40 | 4-G(= 3-G) | FB6 | IO | Current sense input of CH-6 (same pin as No.29, 3-G) |
| 41 | 4-H | VCH3B | 0 | Output of CH-3 (2/3) |
| 42 | 4-J | VCC7 | V | Power supply of CH-7 |
| 43 | 4-K | VOS72 | 0 | Gate drive of high side PMOS switch for CH-7 |
| 44 | 4-L | GND_GD | G | Ground for gate driver of internal power MOS-FET |
| 45 | 5-A | GND_ANA | G | Ground for general analog circuit |

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TERMINAL FUNCTIONS (continued)

| Т | ERMINAL | | | | |
|-----|----------------|----------|-----|--|--|
| NO. | PIN ADDRESS | NAME | I/O | DESCRIPTION | |
| 46 | 5-B | CBG | Ю | Output of BG reference voltage buffer | |
| 47 | 5-C | SS_SYNC | 0 | Current source of soft-start for CH-1, CH-4 and CH-7 | |
| 48 | 5-D | ERR4 | 0 | Output of gm amp for CH-4 | |
| 49 | 5-E | NC | | No connection (recommended to be GND) | |
| 50 | 5-H(= 7-J) | TEST | Ι | Test mode selection Input of serial I/F (same pin as No.67, 7-J) | |
| 51 | 5-J | VCH5 | 0 | Output of CH-5 | |
| 52 | 5-K | VCC5 | V | Power supply of CH-5 | |
| 53 | 5-L | OUT5 | 10 | Primary side terminal of coil L5 for CH-5 | |
| 54 | 6-A | ERR1 | 0 | Output of gm amp for CH-1 | |
| 55 | 6-B | ERR2 | 0 | Output of gm amp for CH-2 | |
| 56 | 6-C(= 6-D) | ERR8 | 0 | Output of gm amp for CH-8 (same pin as No.57, 6-D) | |
| 57 | 6-D(= 6-C) | ERR8 | 0 | Output of gm amp for CH-8 (same pin as No.56, 6-C) | |
| 58 | 6-H | TLD | Ι | Test mode latch input of serial I/F | |
| 59 | 6-J | VCH4 | 0 | Output of CH-4 | |
| 60 | 6-K | OUT4 | 10 | Output side terminal of coil L4 for CH-4 | |
| 61 | 6-L | GND4 | G | Ground for CH-4 | |
| 62 | 7-A | READY | 0 | READY output for Sub-CPU | |
| 63 | 7-B | XRESET | 0 | Low Active RESET output for Sub-CPU | |
| 64 | 7-C | PWR_ON | I | TPS65520 device enable input | |
| 65 | 7-D | LDO4_ON | I | Enable of LDO-4 | |
| 66 | 7-H(= 8-J) | ROMWR | I | Voltage bias to write EEPROM (same pin as No.78, 8-J) | |
| 67 | 7-J(= 5-H) | TEST | I | Test mode selection input of serial I/F (same pin as No.50, 5-H) | |
| 68 | 7-K | LD | I | Latch input of serial I/F | |
| 69 | 7-L | DOUT | 0 | Data output of serial I/F | |
| 70 | 8-A | CREF | 10 | Capacitor of RC filter for band-gap reference | |
| 71 | 8-B | VLDO5 | 0 | Output of LDO-5 | |
| 72 | 8-C | VLDO4 | 0 | Output of LDO-4 | |
| 73 | 8-D | NC | | No connection (recommended to be GND) | |
| 74 | 8-E | NC | | No connection (recommended to be GND) | |
| 75 | 8-F | SSLDO5 | 0 | Current source of soft-start for LDO-5 | |
| 76 | 8-G | BOOT11 | 10 | Bootstrap for primary side of CH-1 | |
| 77 | 8-H | BOOT12 | 10 | Bootstrap for output side of CH-1 | |
| 78 | 8-J(= 7-H) | ROMWR | I | Voltage bias to write EEPROM (same pin as No.66, 7-H) | |
| 79 | 8-K | CLK | I | Clock input of serial I/F | |
| 80 | 8-L | DIN | I | Data input of serial I/F | |
| 81 | 9-A | GND_LDOA | G | Ground for analog circuit of LDO-1,LDO-2,LDO-3 | |
| 82 | 9-B | VLDO2 | 0 | Output of LDO-2 | |
| 83 | 9-C | NC | - | No connection (recommended to be GND) | |
| 84 | 9-D | OUT8A | 10 | Output side terminal of coil L8 for CH-8 (½) | |
| 85 | 9-E | OUT8B | 10 | Output side terminal of coil L8 for CH-8 (2/2) | |
| 86 | 9-F | VCC2 | V | Power supply of CH-2 | |
| 87 | 9-G | VCC1C | V | Power supply of CH-1 (3/3) | |
| 88 | 9-H | GND1A | G | Ground for CH-1 (1/3) | |
| 89 | 9-J | OUT12C | 10 | Output side terminal of coil L1 for CH-1 (3/3) | |
| 90 | 9-K | VCH1B | 0 | Output of CH-1 (2/3) | |
| | ÷ | | ~ | | |

TERMINAL FUNCTIONS (continued)

| ٦ | FERMINAL | | | |
|-----|----------------|--------|-----|---|
| NO. | PIN ADDRESS | NAME | I/O | DESCRIPTION |
| 91 | 9-L | VCH1C | 0 | Output of CH-1 (3/3) |
| 92 | 10-A | VLDO3 | 0 | Output of LDO-3 |
| 93 | 10-B | NC | | No connection (recommended to be GND) |
| 94 | 10-C | VCH8A | 0 | Output of CH-8 (1/2) |
| 95 | 10-D | GND8A | G | Ground for CH-8 (1/2) |
| 96 | 10-E | BOOT2 | Ю | Bootstrap for CH-2 |
| 97 | 10-F | OUT2 | Ю | Primary side terminal of coil L2 for CH-2 |
| 98 | 10-G | VCC1B | V | Power supply of CH-1 (2/3) |
| 99 | 10-H | OUT11B | Ю | Primary side terminal of coil L1 for CH-1 (2/3) |
| 100 | 10-J | GND1B | G | Ground for CH-1 (2/3) |
| 101 | 10-K | OUT12B | ю | Output side terminal of coil L1 for CH-1 (2/3) |
| 102 | 10-L | VCH1A | 0 | Output of CH-1 (1/3) |
| 103 | 11-A | VLDO1 | 0 | Output of LDO-1 |
| 104 | 11-B | VCC8 | V | Power supply of CH-8 |
| 105 | 11-C | VCH8B | 0 | Output of CH-8 (2/2) |
| 106 | 11-D | GND8B | G | Ground for CH-8 (2/2) |
| 107 | 11-E | VCH2 | 0 | Output of CH-2 |
| 108 | 11-F | GND2 | G | Ground for CH-2 |
| 109 | 11-G | VCC1A | V | Power supply of CH-1 (1/3) |
| 110 | 11-H | OUT11A | ю | Primary side terminal of coil L1 for CH-1 (1/3) |
| 111 | 11-J | OUT11C | ю | Primary side terminal of coil L1 for CH-1 (3/3) |
| 112 | 11-K | GND1C | G | Ground for CH-1 (3/3) |
| 113 | 11-L | OUT12A | ю | Output side terminal of coil L1 for CH-1 (1/3) |

REGISTER MAP

Some switching regulators allow the output voltage to be changed according to control register settings. However, changing the voltage setting while a regulator is operating may cause the output to overshoot and exceed the rating. Be careful when dynamically changing the regulator output voltage.

| NAME | POSITION | DESCRIPTION | |
|--------|---------------|---|--|
| parity | D[47] - D[40] | parity data | |
| CH7-SW | D[38] | VOS71, load side switch of CH-7 | |
| Dmax7 | D[37] - D[36] | duty setting of CH-7 | |
| Dmax5 | D[35] - D[34] | duty setting of CH-5 | |
| Dmax4 | D[33] - D[32] | duty setting of CH-4 | |
| CH3-SW | D[31] - D[30] | Load side switch of CH-3 | |
| Dmax3 | D[29] - D[28] | duty setting of CH-3, CH-1(UP,CROSS) and CH-8 | |
| Vout7 | D[27] - D[24] | Voltage setting of CH-7 | |
| Vout5 | D[23] - D[22] | Voltage setting of CH-5 | |
| Vout4 | D[21] - D[20] | Voltage setting of CH-4 | |
| Vout3 | D[19] - D[16] | Voltage setting of CH-3 | |
| Vout2 | D[15] - D[12] | Voltage setting of CH-2 | |
| Vout1 | D[11] - D[08] | Voltage setting of CH-1 | |
| LDO5Vo | D[07] - D[06] | Voltage setting of LDO-5 | |
| LDOSW5 | D[05] | LDO-5 ON/OFF switch | |
| LDOSW3 | D[04] | LDO-3 ON/OFF switch | |
| Dmax6 | D[03] - D[02] | duty setting of CH-6 | |
| Vout6B | D[01] - D[00] | Back-light LED current of CH-6 | |

LIST OF REGISTERS

CH7-SW

| D[39] | D[38] | D[37] | D[36] | ON/OFF | |
|-------|-------|-------|-------|--------|---------|
| * | 0 | * | * | OFF | default |
| * | 1 | * | * | ON | |

| DI201 | D[38] | D[07] | DIACI | | DUTY [%] | | |
|-------|-------|-------|-------|-----|----------|-----|---------|
| D[39] | | D[37] | D[36] | MIN | TYP | MAX | |
| * | * | 0 | 0 | 82 | 86 | 91 | default |
| * | * | 0 | 1 | 77 | 81 | 86 | |
| * | * | 1 | 0 | 72 | 76 | 81 | |
| * | * | 1 | 1 | 67 | 71 | 76 | |

Dmax5 DUTY [%] D[35] D[34] D[33] D[32] MIN TYP MAX 0 0 * * 84 88 92 default * * 79 87 0 1 83 0 * * 74 78 82 1 * * 69 73 77 1 1

Dmax7



| Dmax4 | |
|-------|--|
|-------|--|

| D[25] | D[24] | D[33] | D[30] | | DUTY [%] | | |
|-------|-------|-------|-------|-----|----------|-----|---------|
| D[35] | D[34] | D[33] | D[32] | MIN | TYP | MAX | |
| * | * | 0 | 0 | 92 | 94 | 96 | default |
| * | * | 0 | 1 | 90 | 92 | 94 | |
| * | * | 1 | 0 | 88 | 90 | 92 | |
| * | * | 1 | 1 | 86 | 88 | 90 | |

CH3-SW

| D[31] | D[30] | D[29] | D[28] | ON/OFF | |
|-------|-------|-------|-------|--------|---------|
| 0 | 0 | * | * | OFF | default |
| 0 | 1 | * | * | OFF | |
| 1 | 0 | * | * | OFF | |
| 1 | 1 | * | * | ON | |

Dmax3

| D[24] | D[20] | 0[20] | 1001 | | DUTY [% | 5] | |
|-------|-------|-------|-------|-----|---------|-----|-----------|
| D[31] | D[30] | D[29] | D[28] | MIN | TYP | MAX | |
| * | * | 0 | 0 | 82 | 86 | 91 | default |
| * | * | 0 | 1 | 77 | 81 | 86 | |
| * | * | 1 | 0 | 72 | 76 | 81 | recommend |
| * | * | 1 | 1 | 67 | 71 | 76 | |

Vout7

| D[07] | Diaci | DIAEI | DIA | Output | Voltage [V] | |
|-------|-------|-------|-------|--------|-------------|---------|
| D[27] | D[26] | D[25] | D[24] | DOWN | UP | |
| 0 | 0 | 0 | 0 | 3.10 | 4.90 | default |
| 0 | 0 | 0 | 1 | 3.05 | 4.85 | |
| 0 | 0 | 1 | 0 | 3.00 | 4.80 | |
| 0 | 0 | 1 | 1 | 2.95 | 4.75 | |
| 0 | 1 | 0 | 0 | 2.90 | 4.70 | |
| | 1 | 0 | 1 | 2.85 | 4.65 | |
| 0 | 1 | 1 | 0 | 2.80 | 4.60 | |
| 0 | 1 | 1 | 1 | 2.75 | 4.55 | |
| 1 | 0 | 0 | 0 | 2.70 | 4.50 | |
| 1 | 0 | 0 | 1 | 2.65 | 4.45 | |
| 1 | 0 | 1 | 0 | 2.60 | 4.40 | |
| 1 | 0 | 1 | 1 | 2.55 | 5.10 | |
| 1 | 1 | 0 | 0 | 2.50 | 5.05 | |
| 1 | 1 | 0 | 1 | 3.20 | 5.00 | |
| 1 | 1 | 1 | 0 | 3.15 | 4.95 | |
| 1 | 1 | 1 | 1 | 3.10 | 4.90 | |

Vout5

| D[23] | D[22] | D[21] | D[20] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|---------|
| 0 | 0 | * | * | -7.5 | default |
| 0 | 1 | * | * | -8.0 | |

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TPS65520





Vout5 (continued)

| D[23] | D[22] | D[21] | D[20] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|--|
| 1 | 0 | * | * | -8.5 | |
| 1 | 1 | * | * | -9.0 | |

Vout4

| D[19] | D[18] | D[17] | D[16] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|---------|
| * | * | 0 | 0 | 15.0 | default |
| * | * | 0 | 1 | 15.5 | |
| * | * | 1 | 0 | 16.0 | |
| * | * | 1 | 1 | 16.5 | |

Vout3

| D[19] | D[18] | D[17] | D[16] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|---------|
| 0 | 0 | 0 | 0 | 4.90 | default |
| 0 | 0 | 0 | 1 | 4.85 | |
| 0 | 0 | 1 | 0 | 4.80 | |
| 0 | 0 | 1 | 1 | 4.75 | |
| 0 | 1 | 0 | 0 | 4.70 | |
| 0 | 1 | 0 | 1 | 4.65 | |
| 0 | 1 | 1 | 0 | 4.60 | |
| 0 | 1 | 1 | 1 | 4.55 | |
| 1 | 0 | 0 | 0 | 4.50 | |
| 1 | 0 | 0 | 1 | 5.20 | |
| 1 | 0 | 1 | 0 | 5.15 | |
| 1 | 0 | 1 | 1 | 5.10 | |
| 1 | 1 | 0 | 0 | 5.05 | |
| 1 | 1 | 0 | 1 | 5.00 | |
| 1 | 1 | 1 | 0 | 4.95 | |
| 1 | 1 | 1 | 1 | 4.90 | |

Vout2

| D[15] | D[14] | D[13] | D[12] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|---------|
| 0 | 0 | 0 | 0 | 1.20 | default |
| 0 | 0 | 0 | 1 | 1.15 | |
| 0 | 0 | 1 | 0 | 1.10 | |
| 0 | 0 | 1 | 1 | 1.80 | |
| 0 | 1 | 0 | 0 | 1.75 | |
| 0 | 1 | 0 | 1 | 1.70 | |
| 0 | 1 | 1 | 0 | 1.65 | |
| 0 | 1 | 1 | 1 | 1.60 | |
| 1 | 0 | 0 | 0 | 1.55 | |
| 1 | 0 | 0 | 1 | 1.50 | |
| 1 | 0 | 1 | 0 | 1.45 | |
| 1 | 0 | 1 | 1 | 1.40 | |
| 1 | 1 | 0 | 0 | 1.35 | |
| 1 | 1 | 0 | 1 | 1.30 | |
| 1 | 1 | 1 | 0 | 1.25 | |
| 1 | 1 | 1 | 1 | 1.225 | |

| | Vout1 | | | | | | | |
|-------|-------|-------|--------|--------------------|-----------------|--|--|--|
| D[11] | D[10] | D[09] | D[08] | Output Voltage [V] | | | | |
| 0 | 0 | 0 | 0 | 2.80 | default | | | |
| 0 | 0 | 0 | 1 | 2.75 | | | | |
| 0 | 0 | 1 | 0 | 2.70 | | | | |
| 0 | 0 | 1 | 1 | 2.65 | | | | |
| 0 | 1 | 0 | 0 | 2.60 | not recommended | | | |
| 0 | 1 | 0 | 1 | 2.55 | not recommended | | | |
| 0 | 1 | 1 | 0 | 2.50 | not recommended | | | |
| 0 | 1 | 1 | 1 | 3.20 | | | | |
| 1 | 0 | 0 | 0 | 3.15 | | | | |
| 1 | 0 | 0 | 1 | 3.10 | | | | |
| 1 | 0 | 1 | 0 3.05 | 3.05 | | | | |
| 1 | 0 | 1 | 1 | 3.00 | | | | |
| 1 | 1 | 0 | 0 | 2.95 | | | | |
| 1 | 1 | 0 | 1 | 2.90 | | | | |
| 1 | 1 | 1 | 0 | 2.85 | | | | |
| 1 | 1 | 1 | 1 | 2.825 | | | | |

LDO5Vo

| D[07] | D[06] | D[05] | D[04] | Output Voltage [V] | |
|-------|-------|-------|-------|--------------------|---------|
| 0 | 0 | * | * | 13.5 | default |
| 0 | 1 | * | * | 12.5 | |
| 1 | 0 | * | * | 12.0 | |
| 1 | 1 | * | * | 8.5 | |

LDOSW5

| D[07] | D[06] | D[05] | D[04] | ON / OFF | |
|-------|-------|-------|-------|----------|---------|
| * | * | 0 | * | OFF | default |
| * | * | 1 | * | ON | |

LDOSW3

| D[07] | D[06] | D[05] | D[04] | ON / OFF | |
|-------|-------|-------|-------|----------|---------|
| * | * | * | 0 | ON | default |
| * | * | * | 1 | OFF | |

| Dillaxo | | | | | | | |
|---------|-------|-------|-------|-----|----------|-----|---------|
| D[02] | D[02] | D[04] | Diagi | | DUTY [%] | | |
| D[03] | D[02] | D[01] | D[00] | MIN | TYP | MAX | |
| 0 | 0 | * | * | 87 | 89 | 91 | default |
| 0 | 1 | * | * | 89 | 91 | 93 | |
| 1 | 0 | * | * | 91 | 93 | 95 | |
| 1 | 1 | * | * | 93 | 95 | 97 | |

Dmax6



Vout6B

| D[03] | D[02] | D[01] D[00] | | Output Current [mA] | | |
|-------|-------|-------------|---|---------------------|---------|--|
| * | * | 0 | 0 | 12.0 | default | |
| * | * | 0 | 1 | 20.0 | | |
| * | * | 1 | 0 | 8.0 | | |
| * | * | 1 | 1 | OFF | | |

EEPROM MAP

Note: TI is shipping ICs with recommended values.

DEFAULT VALUE SETUP BITS

| NAME | POSITION | DESCRIPTION | |
|------------|---------------|---------------------------------------|--|
| Test Mode | D[47] - D[45] | 001: Test1 (write), 010: Test2 (read) | |
| (none) | (D[44]) | (not used) | |
| TRIM_DTC0 | D[43] - D[42] | Trimming for DTC of Tr/Tf, CH-1,CH-2 | |
| TRIM_DTCR0 | D[41] - D[40] | Trimming for DTC of Tr, CH-3,CH-8 | |
| TRIM_DTCR1 | D[39] - D[38] | Trimming for DTC of Tr, CH-7 | |
| TRIM_DTCF0 | D[37] - D[36] | Trimming for DTC of Tf, CH-3,CH-8 | |
| TRIM_DTCF1 | D[35] - D[34] | Trimming for DTC of Tf, CH-7 | |

TRIMMING BITS

| NAME | POSITION | DESCRIPTION | |
|------------|---------------|---|--|
| Test Mode | D[47] - D[45] | 100: Test1(write), 101: Test2 (read) | |
| TRIM_BG | (5[bit]) | Trimming for band-gap reference voltage | |
| TRIM_OSC | (3[bit]) | Trimming for oscillator frequency | |
| TRIM_GAIN0 | (2[bit]) | Trimming for AMP gain of CH-1 | |
| TRIM_VOFF0 | (2[bit]) | Trimming for AMP offset voltage of CH-1 | |

PROTECTION STATUS READ MAP

| NAME | POSITION | DESCRIPTION | |
|-----------|---------------|------------------------------|--|
| Test Mode | D[47] - D[45] | 011: Test3 | |
| SCP7 | D[12] | SCP7 to previous system down | |
| (none) | (D[11]) | (not assigned, always L) | |
| SCP5 | D[10] | SCP5 to previous system down | |
| SCP4 | D[09] | SCP4 to previous system down | |
| SCP3 | D[08] | SCP3 to previous system down | |
| SCP2 | D[07] | SCP2 to previous system down | |
| SCP1 | D[06] | SCP1 to previous system down | |
| OVP7 | D[05] | OVP7 to previous system down | |
| OVP6 | D[04] | OVP6 to previous system down | |
| OVP3 | D[03] | OVP3 to previous system down | |
| OVP2 | D[02] | OVP2 to previous system down | |
| TSD | D[01] | TSD to previous system down | |

TPS65520 BLOCK CONFIGURATION

Figure 16 shows the overall block configuration of the TPS65520. Note that the figure is simplified for clarity and does not show accurate details for the IC wiring, pin layout, and internal component layout.

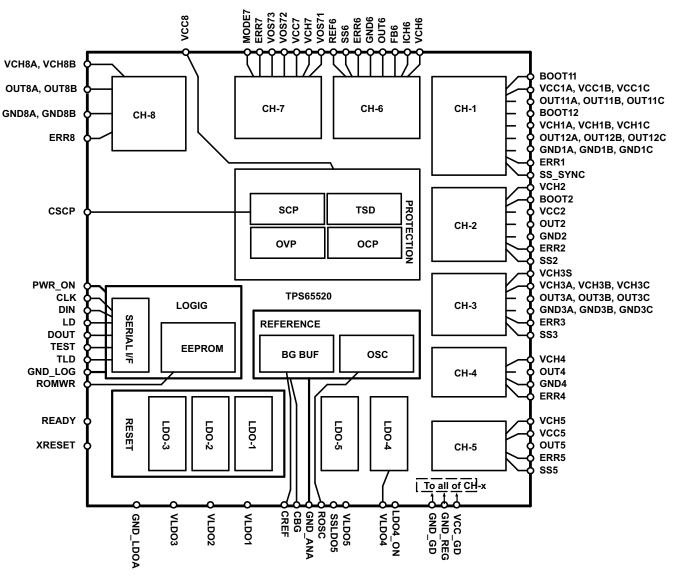


Figure 16. TPS65520 Block Diagram



FUNCTIONAL DESCRIPTION

COMMON SWITCHING REGULATOR FUNCTIONS

The following sections describe the common features for all switching regulators.

MAXIMUM DUTY CYCLE CONTROL

The maximum duty cycle control is applied to each channel to prevent a 100% on condition.

For CH-3, CH-4, CH-5, CH-6, and CH-7, control registers are provided to adjust the maximum duty cycle settings that affects the channel characteristics substantially.

For CH-1 (step-up and step-up/down) and CH-8, which have relatively large margins for maximum duty cycle control, settings are linked to CH-3 to simplify circuits.

Table 3 lists settings for each channel:

| SETTINGS | | | | | |
|--------------|--|--|--|--|--|
| (Dmax3) | | | | | |
| Fixed at 95% | | | | | |
| Fixed at 95% | | | | | |
| Dmax3 | | | | | |
| Dmax4 | | | | | |
| Dmax5 | | | | | |
| Dmax6 | | | | | |
| Dmax7 | | | | | |
| (Dmax3) | | | | | |
| | | | | | |

Table 3. Settings for Each Channel

DEAD TIME CONTROL

The synchronous rectification channels are subjected to dead time control to prevent a flow-through current. The dead time for each channel is fixed by the EEPROM, as shown in Table 4:

| Table 4. | | | | | |
|-----------|--------|--------|--------|--------|--------|
| Channel | CH-1 | CH-2 | CH-3 | CH-7 | CH-8 |
| Dead time | 30[ns] | 30[ns] | 30[ns] | 40[ns] | 30[ns] |

CH-1

CH-1 is a step-up/down switching regulator for I/F 3-V power supplies, including those for the main processor, TMS320[™] DSP family, and ASIC. Figure 17 shows its block diagram and the connection of external devices.

CH-1 operates by automatically switching between two modes: *step-up to step-up/down* mode and *step-down* mode. In Step-up to step-up/down mode, the channel shifts between step-up and step-up/down operations within the single mode.

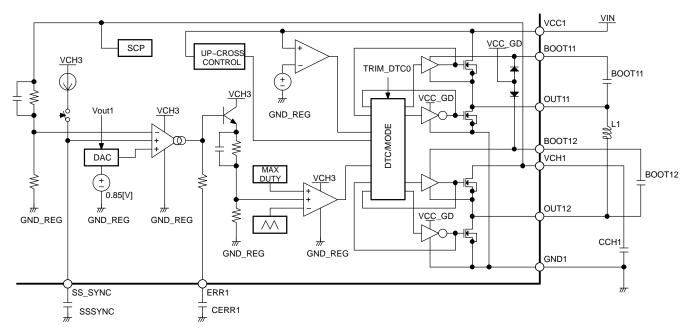
Table 5 shows the rough relationship between the input voltage and CH-1 mode. Note that the threshold values shown in the table are merely guidelines because the actual CH-1 circuit finely adjusts the threshold voltages to maximize efficiency. *Electrical Characteristics* section for the voltage specifications of thresholds for switching between step-up to step-up/down mode and step-down mode (Vmod11 and Vmod12).

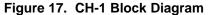
CH-1 incorporates a voltage retention circuit that maintains the boosting power supply voltage when the channel is performing step-up only or step-down only operation.

CH-1 supports the SCP and soft-start functions. The soft-start function is common to CH-1, CH-4, and CH-7.

| Table 5. | | | | | |
|-------------------------|-------------------------|--------------|--|--|--|
| VCC1 [V] ⁽¹⁾ | CH-1 MODE | OPERATION | | | |
| ~ 2.3 | Step-up to step-up/Down | Step-up | | | |
| 2.3 ~ 3.78 | Step-up to step-up/down | Step-up/down | | | |
| 3.5 ~ | Step-down | - | | | |

(1) The voltages shown are for guideline purposes only.





CH-2

CH-2 is a step-down switching regulator for core 1.x-V power supplies, including those for the main processor, TMS360[™] DSP family, and ASIC. Figure 18 shows the block diagram and the connection of external devices.

CH-2 supports the OVP, SCP and soft-start functions.



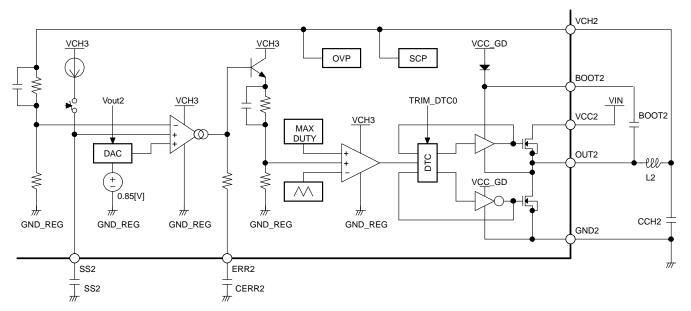


Figure 18. CH-2 Block Diagram

CH-3 is a step-up switching regulator for 5-V power supplies, including those for the motor and audio IC. Figure 19 shows its block diagram and the connection of external devices.

CH-3 incorporates a PMOS switch, which prevents the input voltage from appearing on the output side when the channel is turned off. Without the switch, the parasitic diode in the internal PMOS carries the input voltage from coil (L3) and causes a current to flow into the load. This switch turns the VCH3S output pin on or off according to the settings in the CH3-SW control register.

The motor driver, as a load for CH-3, is a switch itself. It does not have a current path so that it can be connected to the VCH3 pin. Other current loads, which may have current paths, are intended to be connected to the VCH3S pin.

When CH-3 is activated, CH-8 supplies power to CH-3. To prevent overload on CH-8 during startup, CH-3 compares VCH8 and VCH3 and performs asynchronous rectification using a body diode until VCH3 exceeds VCH8.

CH-3 supports the OVP, SCP and soft-start functions.

When using the TPS65520, note the following:

- The following conditions must be satisfied to use a 5-V ac adaptor:
 - An appropriate voltage drop circuit is provided so that the input voltages for step-up CH-3 are at least 0.3 V lower than the values specified with the control register.

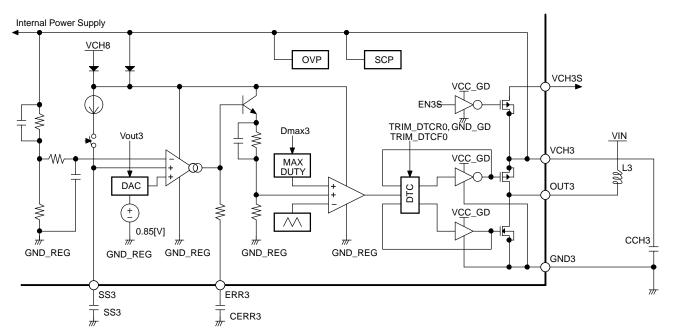


Figure 19. CH-3 Block Diagram

CH-4 is a step-up switching regulator for 15-V power supplies the LCD and CCD. Figure 20 shows its block diagram and the connection of external devices.

CH-4 is controlled by asynchronous rectification because it outputs a high voltage and does not benefit much from synchronous rectification. An external SBD is connected between the OUT4 and VCH4 pins as a rectification device for CH-4.

CH-4 supports the SCP and soft-start functions. The soft-start function is common to CH-1, CH-4, and CH-7.

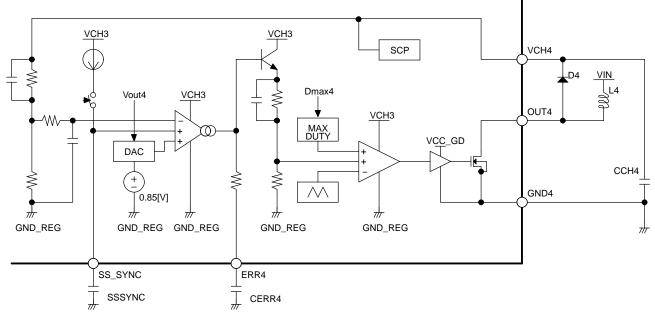


Figure 20. CH-4 Block Diagram



CH-5 is an inversion switching regulator for -8-V power supplies for the LCD and CCD. Figure 21 shows its block diagram and the connection of external devices.

CH-5 supports the SCP and soft-start functions.

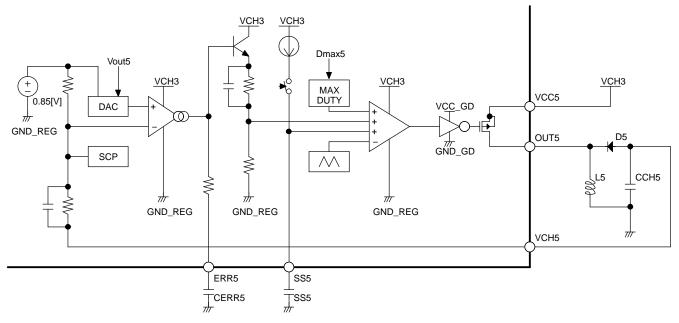


Figure 21. CH-5 Block Diagram

CH-6

CH-6 is a step-up switching regulator for driving the power supply for the LCD backlight LED. CH-6 is controlled by monitoring the current flowing through the LED so that it operates as a constant-current driver. Figure 22 shows the block diagram and the connection of external devices.

The output current for CH-6 can be finely adjusted using the REF6 pin. The output current becomes the value specified with the Vout6B control register when the potential of the REF6 pin equals that of the CBG pin. Note that the REF6 pin always expects a voltage to be applied. One example to ensure that an appropriate voltage is applied to the REF6 pin, is to connect it to a DAC or to the CBG pin through a resistor. The following formulas show the relationship between the voltage on the REF6 pin and that on the FB6 pin, which senses the output current:

| 20 mA setting | $V_{(FB6)} = 0.52 \times V_{(REF6)} - 0.002$ |
|---------------|--|
| 12 mA setting | $V_{(FB6)} = 0.52 \times V_{(REF6)} - 0.177$ |
| 8 mA setting | $V_{(FB6)} = 0.52 \times V_{(REF6)} - 0.265$ |

For example, when using 0.85 V of CBG as reference voltage and using 22 Ω of recommended sense resistor, the caluculation is like this: $I_0 = V_{(FB6)} / R_{sense} = (0.52 \times 0.85 \text{ V} - 0.002) / 22 \Omega = 20 \text{ mA}.$

CH-6 supports the OVP, SCP and soft-start functions.

Without serial I/F control, CH-6 is controlled by the voltage of REF6. When the potential of REF6 is out of range between VREF6L and VREF6H, CH-6 is OFF in logical. Soft-start is reset.

According to the state of the MODE7 pin, CH-7 operates either as a *step-up* switching regulator for 5-V power supplies, including those for the motor and audio IC, or as a *step-down* switching regulator for I/F 3-V power supplies, including those for the main processor, TMS320[™] DSP family, and ASIC. Table 6 shows the relationship between the state and mode:

| Table 6. | | | | |
|----------|-----------|--|--|--|
| MODE7 | MODE | | | |
| Н | Step-up | | | |
| L | Step-down | | | |

CH-7 requires different external component connections depending on the MODE7 pin state. Figure 23 shows its block diagram and the connection of external devices for step-up mode. Figure 24 shows its block diagram and the connection of external devices for step-down mode.

When using the TPS65520, note the following:

- The following conditions must be satisfied to use a 5-V ac adaptor:
 - An appropriate voltage drop circuit is provided so that the input voltages for step-up CH-7 (MODE7 = H) are at least 0.3 V lower than the values specified with the control register.

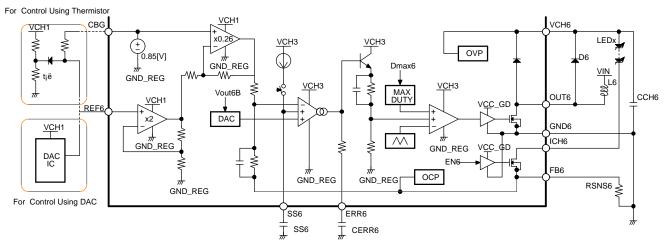


Figure 22. CH-6 Block Diagram

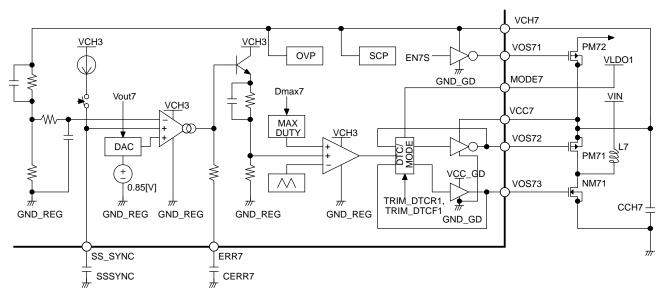


Figure 23. CH-7 Block Diagram (Step-up)

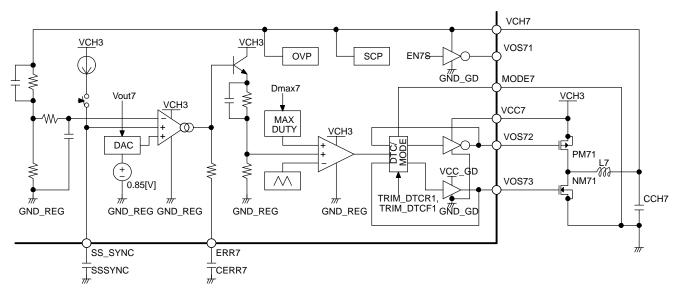


Figure 24. CH-7 Block Diagram (Step-down)

As shown in Figure 24, the step-down circuit configuration uses CH-3 as an input power supply that ensures a voltage higher than the output voltage.

CH-7 has the VOS71 pin for controlling a separate PMOS switch, preventing the input voltage from appearing on the output side when the channel is turned off (MODE7 = H). Without the switch, the parasitic diode in the external PMOS carries the input voltage from coil (L7) which causes a current to flow into the load. This switch turns on or off according to the settings in the CH7-SW control register.

When CH-7 is activated, CH-8 supplies power to CH-7. To prevent overload on CH-8 during startup, CH-7 compares VCH8 and VCH7 and performs asynchronous rectification using a body diode until VCH7 exceeds VCH8.

CH-7 supports the OVP, SCP and soft-start functions. The soft-start function is common to CH-1, CH-4, and CH-7.

When CH-7 is not used, handle the pins as shown in Table 7. CH-7 enters step-down mode with its state equal to the stable output state, stopping operation.

| PIN | HANDLING |
|-------|--|
| ERR7 | 0.1 µF - Connect a 0.1-µF capacitor between the pin and ground |
| VCH7 | VCH1 - Short-circuit to VCH1 |
| VOS71 | Open |
| MODE7 | Short-circuit to the ground |
| VCC7 | Open |
| VOS72 | Open |
| VOS73 | Open |

Table 7.

CH-8

CH-8 is a step-up switching regulator for LDO-1, LDO-2, LDO-3, LDO-4, and the internal power supplies of the TPS65520. CH-8 is a 3.6-V output regulator that outputs the input voltage (VCC8) when it is higher than 3.6 V.

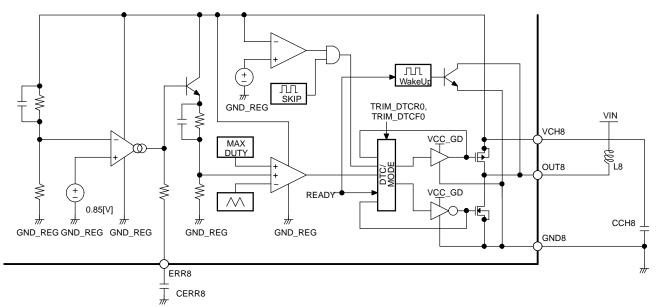
CH-8 is turned on whenever the battery and/or ac adaptor is connected. It operates in skip mode while the PWR_ON pin is low, meaning that only the Sub-CPU real-time clock is operating. Once the PWR_ON pin is driven high, CH-8 enters synchronous rectification mode, where it can supply the maximum load current.

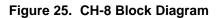
CH-8 has a startup circuit that can start with a low input voltage because the startup of CH-8 enables the entire DSC system to start up. It outputs 3.6 V from a minimum input voltage (VCC8) of 1.6 V.

See the CH-8 operating sequence for details of starting CH-8.

Figure 25 shows its block diagram and the connection of external devices.

CH-8 supports the soft-start function.







LDO-1

LDO-1 takes the CH-8 output voltage as an input and then outputs a voltage of 2.9 V. LDO-1 supports a current limit function, which reduces the output voltage when the current exceeds the specified value.

LDO-2

LDO-2 takes the CH-8 output voltage as an input and then outputs a voltage of 2.9 V. LDO-2 supports a current limit function, which reduces the output voltage when the current exceeds the specified value.

LDO-3

LDO-3 takes the CH-8 output voltage as an input and then outputs a voltage of 3.1 V. LDO-3 supports a current limit function, which reduces the output voltage when the current exceeds the specified value. LDO-3 can be turned on/off using the LDOSW3 control register.

A delay is inserted before LDO-3 is turned on so that the entire system can start up and be stable. LDO-3 cannot be turned on until approximately 30 µs elapse after the detection of READY. DELAY2 in Figure 29 represents this delay.

LDO-4

LDO-4 takes the CH-8 output voltage as an input and then outputs a voltage of 3.1 V. LDO-4 supports a current limit function, which reduces the output voltage when the current exceeds the specified value.

To prevent an inrush current during startup, LDO-4 has a delay so that it is not turned on simultaneously with LDO-3. LDO-4 cannot be turned on until 1.03 ms elapses after the detection of READY. This ensures that LDO-4 is not turned on until 1 ms elapses after the startup of LDO-3, which is turned on 30 µs after READY detection. DELAY3 in Figure 29 represents this delay.

LDO-4 is controlled using the LDO4_ON pin, as follows:

| USB ON | ON/OFF |
|--------|--------|
| Н | On |
| L | Off |

LDO-5

LDO-5 takes the CH-4 output voltage as an input and then outputs a voltage of 8.5 V to 13.5 V for the LCD panel. LDO-5 supports a current limit function, which reduces the output voltage when the current exceeds the specified value. LDO-5 can be turned on/off using the LDOSW5 control register. LDO-3 has a soft-start pin due to the power it drives.

PROTECTION FUNCTIONS

TSD

The thermal shutdown (TSD) function protects the TPS65520 from overheat.

If the TSD activates, the TPS65520 stops all channels other than CH-8. CH-8 expects that the Sub-CPU drives PWR_ON low due to the stop of CH-1 and CH-2, causing the TPS65520 to enter skip mode.

SCP

The short-circuit protection (SCP) function protects the output of each switching regulator from short-circuiting. If the SCP activates, the TPS65520 stops all channels other than CH-8. CH-8 expects that the Sub-CPU drives PWR_ON low due to the stop of CH-1 and CH-2, causing the TPS65520 to enter skip mode.

Figure 26 shows the block diagram, the connection of external devices, and the per-channel short-circuit information from the control section for each switching regulator

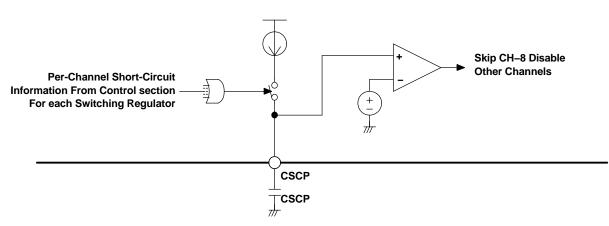


Figure 26. SCP Block Diagram

OVP

The overvoltage protection (OVP) function protects the CH-2, CH-3, CH-6, and CH-7 outputs from overvoltage.

If the OVP for CH-6 activates, the TPS65520 internally latches the CH-6 OVP and disables CH-6. The MOS switch between ICH6 and FB6 is designed to remain on if the OVP activates and discharges the VCH6 potential through a diode and sense resistor. To cancel the OVP for CH-6, drive PWR_ON low. The OVP for CH-6 affects the CH-6 output only.

If the OVP for a channel other than CH-6 activates, the TPS65520 disables the power MOS-FET switching for that channel while still allowing the operation of the channel.

The OVP for channels other than CH-6 does not have a latch function so that the TPS65520 automatically restores normal operation once it exits from the overvoltage state.

OCP

The overcurrent protection (OCP) function protects the CH-6 output from overcurrent.

The OCP monitors the FB6 pin and, if its voltage exceeds 0.85 V, it determines that an overcurrent is flowing through CH-6. If the OCP activates, the TPS65520 disables power MOS-FET switching for CH-6 while still allowing the operation of CH-6. In the same way as with the OVP, the MOS switch between ICH6 and FB6 is designed to remain on if the OCP activates and discharges the VCH6 potential through a diode and sense resistor.

The TPS65520 restarts switching once the voltage on the FB6 pin falls below 0.85 V. The OCP does not have a latch function so that the TPS65520 automatically restores normal operation once it exits from the overcurrent state.

SUB-CPU CONTROL (RESET)

The Sub-CPU function monitors the LDO-2 voltage to output XRESET, and it monitors VCH8 to output READY.

Figure 27 shows a block diagram of this function.

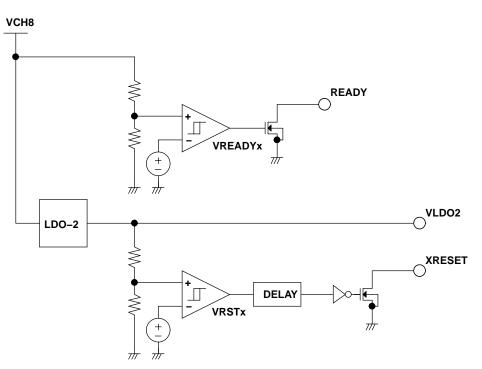


Figure 27. Sub-CPU Control Block Diagram

OPERATION SEQUENCE

SOFT-START

The soft-start function of the TPS65520 controls the constant-current charging of the capacitors connected to the SS_SYNC, SS2, SS3, SS5, SS6, and SSLDO5 pins based on their pin voltages. When the voltage at a soft-start pin becomes approximately 0.85 V, its corresponding regulator output becomes 100%.

SOFT-START OK SIGNAL FOR CH-3

The soft-start circuit for CH-3 has a logic output (internal signal) function that indicates the end of soft-start for sequence control.

Figure 28 shows the entire soft-start circuit. As shown, the voltage on the SS3 pin is used as a reference for the CH-3 control section. The control section operates based on the SS3 voltage or the band gap buffer reference voltage for the CBG pin, whichever is lower.

In Figure 28, the comparator that outputs the SS3OK signal implements the logic output function for sequence control. The threshold value for the comparator is set to a value (VSS3OK) that is sufficiently higher than the band gap buffer reference voltage. It can be assumed that CH-3 has been started when the comparator outputs the SS3OK signal, except when the CH-3 load is heavy or short-circuited.

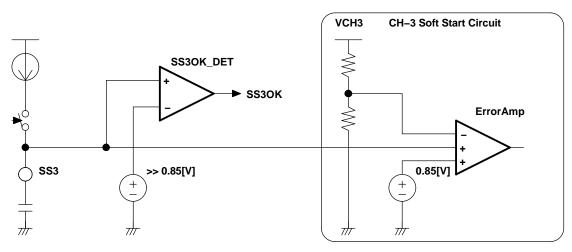


Figure 28. CH-3 Soft-Start Circuit

SEQUENCE CONTROL

Most operations of the TPS65520 are controlled by the Sub-CPU. When a valid power supply, ac adaptor, or battery is inserted, the TPS65520 automatically activates the Sub-CPU. If a Sub-CPU does not exist, the TPS65520 automatically activates the regulators and LDOs using the default values for control registers.

Figure 29 shows the connection of enable signals for the TPS65520. Figure 30 shows a timing chart. In Figure 30, ENREGs, EN3S, EN6, EN7, ENLDO3, and ENLDO5 represent the internal enable signals shown in Figure 29.

The following describes the relationship among enable signals in

- 1. Upon power-up, the TPS65520 starts the wake-up circuit for CH-8 and activates the VCH8 potential. In the figure, only CH-8 is operating.
- 2. Once VCH8 rises, the READY detection circuit is activated and detects READY.
- 3. Upon the detection of READY, CH-8 exits from the wake-up state and enters skip mode. At this time, the blocks in the upper half of the figure can operate. They are turned on if the enable logic signal is valid.
- 4. In skip mode after wake-up, CH-8 enters PWM mode when PWR_ON is driven high.
 - a. PWR_ON has a delay of approximately 60 µs to ensure that the OSC starts completely before channels start operating. DELAY0 in the figure represents this delay.
 - b. A delay of approximately 1 ms is inserted to ensure that CH-8 enters PWM mode completely before channels start operating. DELAY1 in the figure represents this delay.
- 5. Once CH-8 enters PWM mode, each switching regulator channel starts operating. CH-3 starts first. The SS3OK signal from CH-3 causes other channels to start.

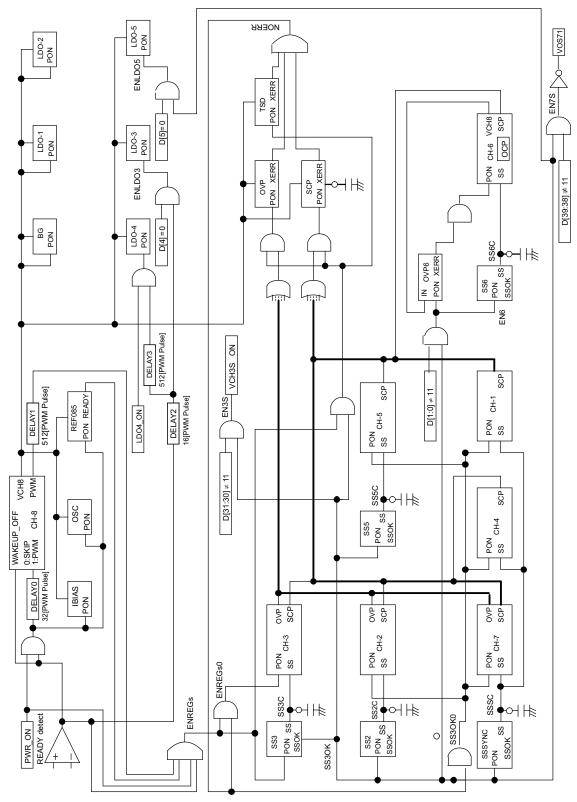
In Figure 30, the TPS65520 performs the following operation, described along the time axis in the figure:

- 1. In response to CH-8 starting up, the internal logic reset signal is generated at the same time as READY being canceled, thus resetting the maintained status values.
- On the rising edge of PWR_ON, CH-8 exits from skip mode and enters PWM mode. The DELAY0 and DELAY1 blocks, shown in the upper part of Figure 29, insert delays to ensure that the mode transition is over before channels start operating, resulting in a total delay of 544 PWM pulses to complete this process.
- 3. Upon the mode transition of CH-8, CH-3 starts using the soft-start procedure.
- 4. The SS3OK signal output during the soft-start of CH-3 causes all other blocks to be enabled at one time, after which normal operation starts.
- 5. On the falling edge of SYDDON, all channels are disabled at one time.



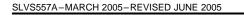
The shaded portions of Figure 30 represent the on/off control applied by the Sub-CPU (if used) through the serial interface. If a Sub-CPU is used, control registers are written between the rising edges of XRESET and PWR_ON. Any channels that have been turned off do not start until the Sub-CPU turns them on again. If the Sub-CPU specifies *off* for a channel that has been active from the startup, the channel goes off from that instant.

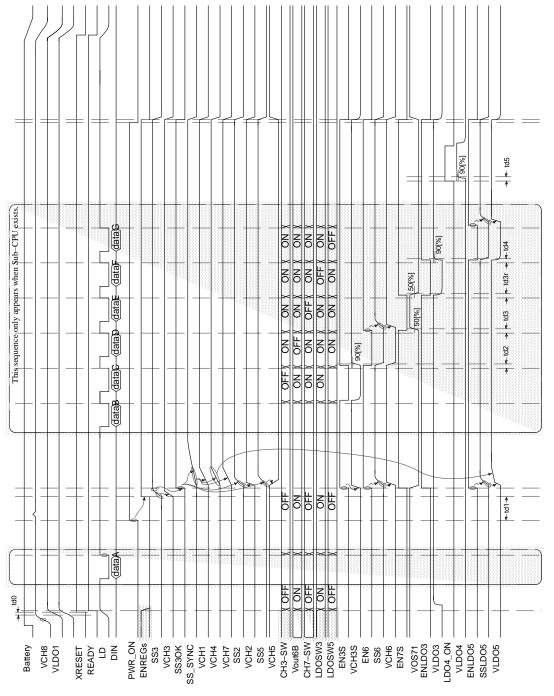
If a Sub-CPU is not used, the timing waveforms do not have the shaded portions. All channels are turned on with default values set in the control registers.





The shaded portions apply only when a Sub-CPU is used.







SERIAL INTERFACE, CONTROL REGISTERS, AND EEPROMS

The logic control section of the TPS65520 consists of the serial interface, control registers, and EEPROMs. See the *EEPROM MAP* section for details of control registers, EEPROMs, and the bit assignment for reading the protection states.

The logic section operates in either of two operating modes: para mode or test mode. Each mode is described in this section.

Figure 34 shows the overall block configuration. In the figure, the 48-bit Shift Register block accepts D[47] (MSB) last in the time sequence. Figure 31 shows the configuration of the parity judgment circuit.

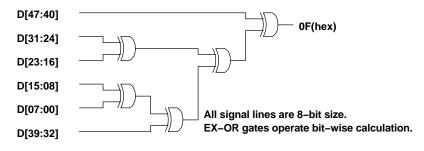


Figure 31. Configuration for Parity Bit Calculation

NORMAL MODE

Driving the TEST input signal low selects para mode. In this mode, the TPS65520 allows access to the control registers.

Figure 32 shows the shift register configuration from input DIN to output DOUT. Figure 33 shows a single access cycle. As shown in Figure 33, once 48 bits have been input to the shift register, the TPS65520 determines the parity according to the output from DOUT and latches the input data using the LD input signal.

In para mode, DOUT directly reflects the output from the parity check block, which is a random logic circuit. Note, therefore, that any circuit that responds to the edge of DOUT may cause malfunctioning connections.

In para mode, the EEPROMs send the written data to each internal block.



Figure 32. Shift Register Configuration in Para Mode

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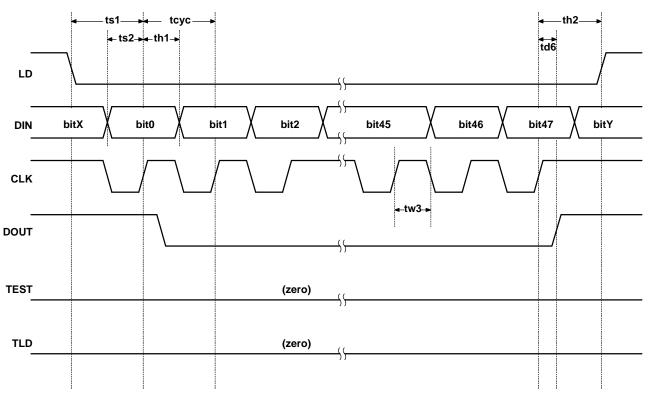


Figure 33. Serial Interface Timing Chart in Para Mode

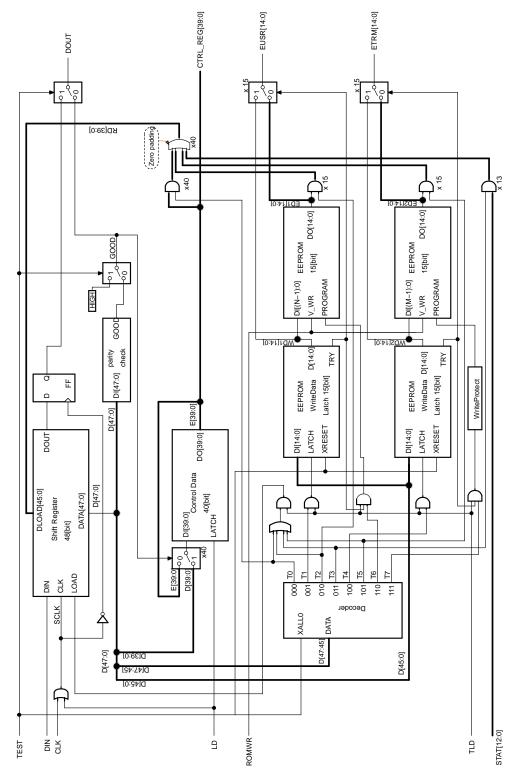


Figure 34. Serial Interface Block Diagram



TEST MODE

Driving the TEST input signal high selects test mode. In this mode, the TPS65520 allows access to all logic functions, including EEPROMs. The following test operations are supported:

- Test A: In the same way as Para mode, the TPS65520 allows access to the control registers. Unlike the para mode, no parity check is performed. The parity judgment result is internally fixed to *OK* and the contents of the shift register are sent to DOUT.
- Test 0: The contents of the control registers are copied to the shift register in synchronization with the TLD input signal. After copying, a CLK input causes the control register value to appear at DOUT.
- Test 1: Prepare (latch) the data to be written to the user setup EEPROM. When Test 6 is performed subsequently, the latched data is written to the EEPROM. After the data is latched, any internal blocks that reference values from EEPROM will see the latched data, instead of the data stored in EEPROM.
- Test 2: The contents of the user setup EEPROM are copied to the shift register in synchronization with the TLD input signal. After copying, a CLK input causes the value from the user setup EEPROM to appear at DOUT.
- Test 3: The states of the protection functions are copied to the shift register in synchronization with the TLD input signal. After copying, a CLK input causes the protection state value to appear at DOUT.
- Test 4: Prepare (latch) the data to be written to the trimming EEPROM. When Test 7 is performed subsequently, the latched data is written to the EEPROM. After the data is latched, any internal blocks that reference values from EEPROM will see the latched data, instead of the data stored in EEPROM.
- Test 5: The contents of the trimming EEPROM are copied to the shift register in synchronization with the TLD input signal. After copying, a CLK input causes the value from the trimming EEPROM to appear at DOUT.
- Test 6: Data is written to the user setup EEPROM.
- Test 7: Data is written to the trimming EEPROM.
- Test Mode Switching: Test A does not require a transition to a special mode. Its operation is the same as in normal mode, except the difference in the DOUT output.
- Tests 0 to 7 require explicit mode switching using the Decoder shown in Figure 34. The Decoder uses the three high-order bits in the shift register to change the mode. Table 8 shows the bit assignment.

| Table 0. Dit Assignments | | | | | | | |
|--------------------------|-------|-------|--------|--|--|--|--|
| D[47] | D[46] | D[45] | MODE | | | | |
| * | * | * | Test A | | | | |
| 0 | 0 | 0 | Test 0 | | | | |
| 0 | 0 | 1 | Test 1 | | | | |
| 0 | 1 | 0 | Test 2 | | | | |
| 0 | 1 | 1 | Test 3 | | | | |
| 1 | 0 | 0 | Test 4 | | | | |
| 1 | 0 | 1 | Test 5 | | | | |
| 1 | 1 | 0 | Test 6 | | | | |
| 1 | 1 | 1 | Test 7 | | | | |

Table 8. Bit Assignments

• Information Read Mode: In Test mode, Tests 0, 2, 3, and 5 have a common function: copy some TPS65520 internal logic values to the shift register and read them from DOUT. Since their operations are similar, this section describes them together.

Figure 35 to Figure 38 shows the shift register configuration from input DIN and output DOUT as well as changes in the shift register caused by a TLD input pulse.

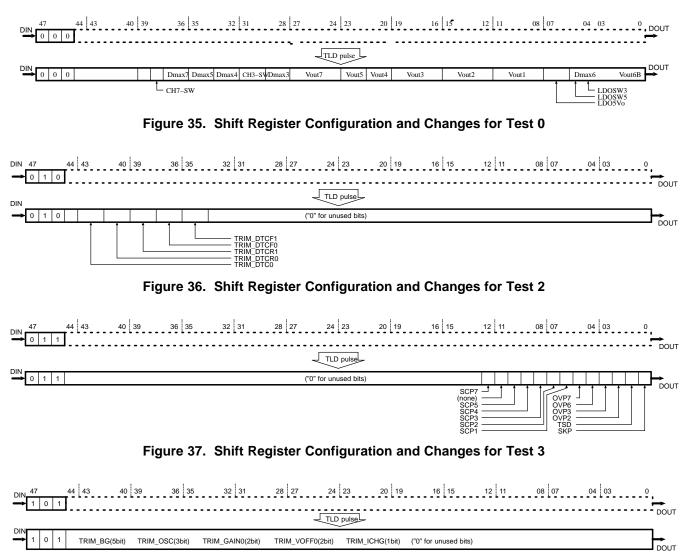


Figure 38. Shift Register Configuration and Changes for Test 5

Figure 39 takes Test 0 as an example and shows a single access cycle. As shown in the figure, a TLD input from DIN, following the input of the data 000 (bin) to select Test 0, causes the contents of the control registers to be copied to the shift register. Subsequent 48-bit CLK inputs enables the user to read data sequentially from DOUT.

The values read in Test 3 are cleared once PWR_ON is pulled high. Data should, therefore, be read while PWR_ON is low after protection activates.

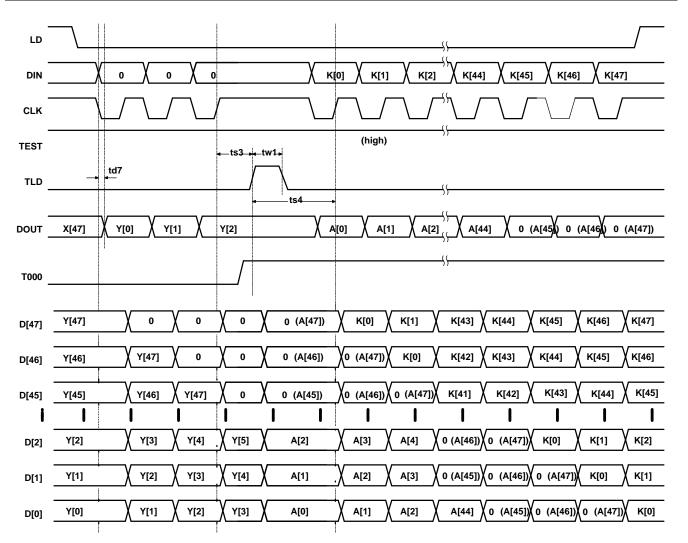


Figure 39. Serial Interface Timing Chart in Test Mode: Information Read

EEPROM Data Input Mode: In test mode, Tests 1 and 4 have a common function: internally latch the data to be written to an EEPROM in the TPS65520 temporarily. Since their operations are similar, this section describes them together.

Figure 40 and Figure 41 show the shift register configuration from input DIN and output DOUT.

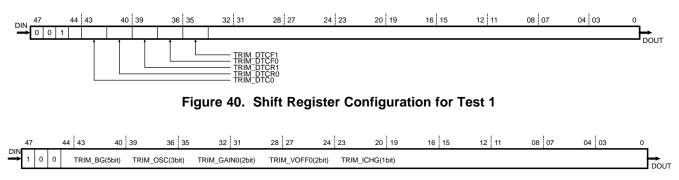




Figure 42 takes test 1 as an example and shows a single access cycle. As shown in the figure, a TLD input from DIN, following the input of the data to be written to the EEPROM and then *001* (bin) to select Test 1, causes the TPS65520 to internally latch the data to be written temporarily. If data is latched at least once by TLD, any internal blocks that reference values from EEPROM will see the latched data, instead of the data stored in EEPROM, until TEST is driven low.

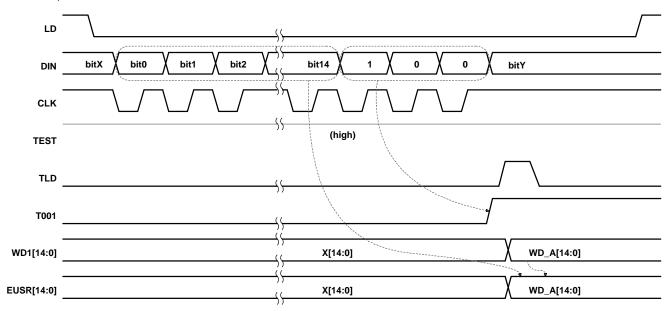


Figure 42. Serial Interface Timing Chart in Test Mode: EEPROM Data Input

EEPROM Data Write Mode: In test mode, tests 6 and 7 have a common function: write data to an EEPROM in the TPS65520. Since their operations are similar, this section describes them together.

Figure 43 takes test 6 as an example and shows a single access cycle. As shown in the figure, the EEPROM write voltage, ROMWR, is applied after the data *110* (bin) is input from DIN to select Test 6. A TLD input following the rise of ROMSW triggers a write to the EEPROM. The duration of the write depends on the TLD pulse width. Once the write is finished, stop applying ROMWR.

For Test 7, write protection is applied to the write timing signal generated using TLD.

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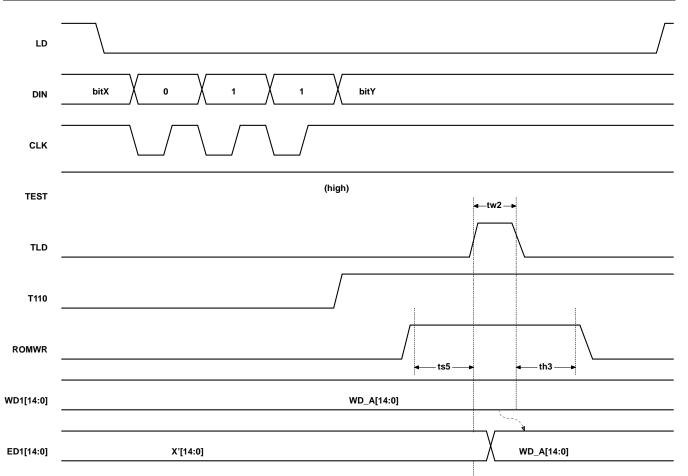


Figure 43. Serial Interface Timing Chart in Test Mode: EEPROM Data Write

Table 9. EVM-XX LIST OF MATERIALS

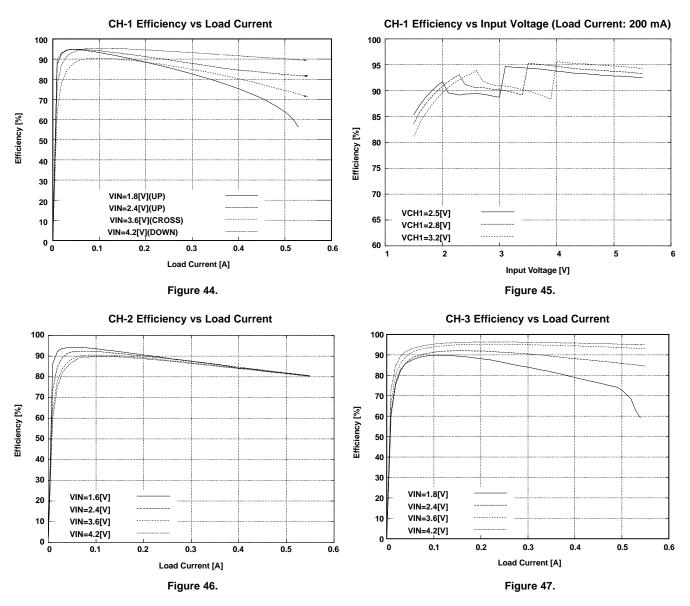
| NAME | VALUE | DEVICE TYPE | EXAMPLE PART NAME |
|-------|----------------|-------------------|--|
| PM71 | (CH-7 PMOS) | PMOS | SANYO MCH3306/CPH5802 |
| PM72 | (CH-7 Load SW) | PMOS | SANYO MCH3306/CPH5802 |
| NM71 | (CH-7 NMOS) | NMOS | SANYO MCH3406/MCH5801 |
| D4 | (CH-4) | SBD | SANYO SBS004M |
| D5 | (CH-5) | SBD | SANYO SBS004M |
| D6 | (CH-6) | SBD | SANYO SBS004M |
| LED6 | (CH-6) | White LED | NICHIA NSCW100-T38,NSCW100-T39 |
| ROSC | 150 kΩ | Resistor | |
| RSNS6 | 22 kΩ | Resistor | |
| CERR1 | 0.01 µF | Ceramic capacitor | TDK C0603[B, 6.3V], Murata GRP03[0603, B, 6.3] |
| CERR2 | 0.01 µF | Ceramic capacitor | TDK C0603[B, 6.3V], Murata GRP03[0603, B, 6.3] |
| CERR3 | 0.022 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| CERR4 | 0.01 µF | Ceramic capacitor | TDK C0603[B, 6.3V], Murata GRP03[0603, B, 6.3] |
| CERR5 | 0.022 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| CERR6 | 1 μF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| CERR7 | 0.1 μF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| CERR8 | 0.01 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |

Table 9. EVM-XX LIST OF MATERIALS (continued)

| NAME | VALUE | DEVICE TYPE | EXAMPLE PART NAME |
|---------|---------|---------------------|---|
| CCH1 | 22 µF | Ceramic capacitor | TDK C3225[B, 6.3V] |
| CCH2 | 10 μF | Ceramic capacitor | TDK C2012[B, 6.3V] |
| ССНЗ | 22 µF | Ceramic capacitor | TDK C3225[22 µF, B, 6.3V] |
| CCH4 | 10 µF | Ceramic capacitor | TDK C3225[10 μF, B, 25V] |
| CCH5 | 10 µF | Ceramic capacitor | (unknown)[10 µF, B, 10V] |
| CCH6 | 10 µF | Ceramic capacitor | TDK C3225[10 µF, B, 25V] |
| CCH7 | 22 µF | Ceramic capacitor | TDK C3225[22 µF, B, 6.3V] |
| CCH8 | 10 µF | Ceramic capacitor | TDK C2012[B, 6.3V] |
| CLDO1 | 4.7 μF | Ceramic capacitor | TDK C2012[B, 6.3V], Murata GRM21[2012, B, 6.3V] |
| CLDO2 | 22 µF | Tantalium capacitor | |
| CLDO3 | 4.7 µF | Ceramic capacitor | TDK C2012[B, 6.3V], Murata GRM21[2012, B, 6.3V] |
| CLDO4 | 10 µF | Ceramic capacitor | TDK C2012[B, 6.3V] |
| CLDO5 | 22 µF | | |
| SS_SYNC | | Ceramic capacitor | |
| SS2 | | Ceramic capacitor | |
| SS3 | | Ceramic capacitor | |
| SS5 | | Ceramic capacitor | |
| SS6 | | Ceramic capacitor | |
| SSLDO5 | | Ceramic capacitor | |
| BOOT11 | 0.01 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| BOOT12 | 0.01 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| BOOT2 | 0.01 µF | Ceramic capacitor | TDK C1005[B, 25V], Murata GRP15[1005, B, 16V] |
| CSCP | | Ceramic capacitor | |
| CBG | 1 µF | Ceramic capacitor | TDK C0603[B, 6.3V], Murata GRP03[0603, B, 6.3] |
| CREF | 0.1 µF | Ceramic capacitor | TDK C0603[B, 6.3V], Murata GRP03[0603, B, 6.3] |
| L1 | 10 µH | | TDK RLF5018 |
| L2 | 10 µH | | TDK RLF5018 |
| L3 | 10 µH | | Sumida CDRH6D28 |
| L4 | 4.7 µH | | TDK RLF5018 |
| L5 | 33 µH | | DK RLF5018 |
| L6 | 4.7 µH | | TDK RLF5018 |
| L7 | 10 µH | | Sumida CDRH6D28 L8 |
| L8 | 10 µH | | TDK RLF5018 |



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)

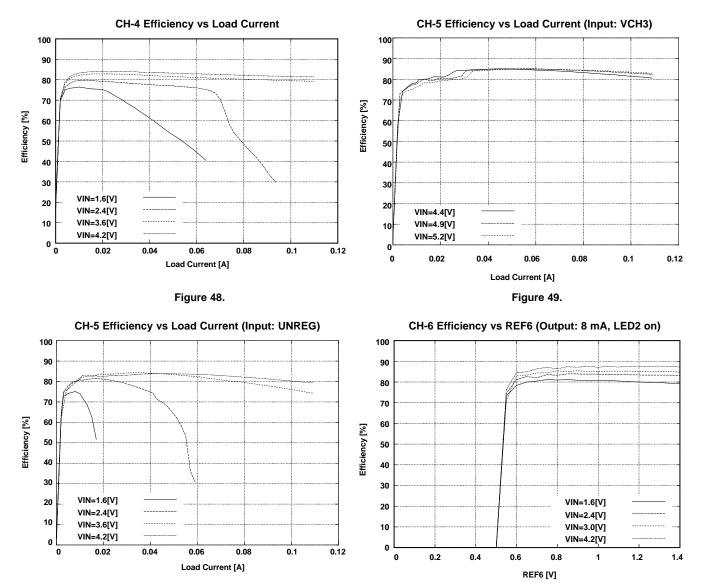
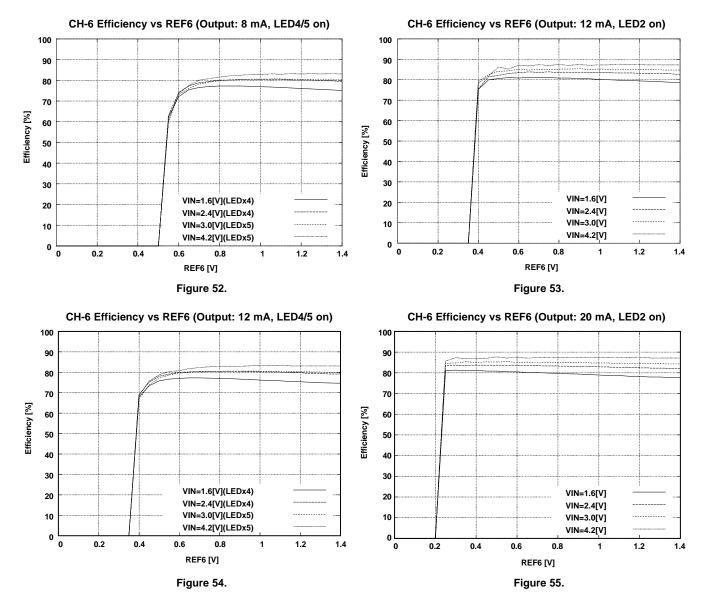
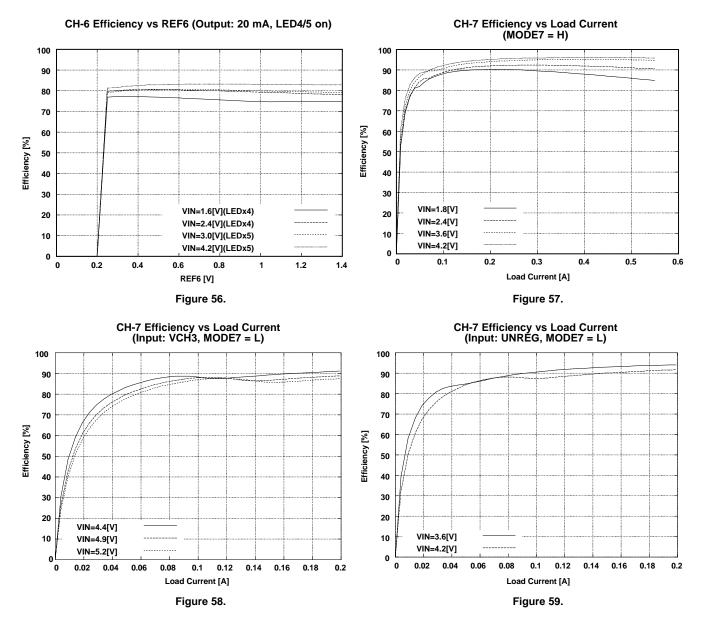


Figure 50.

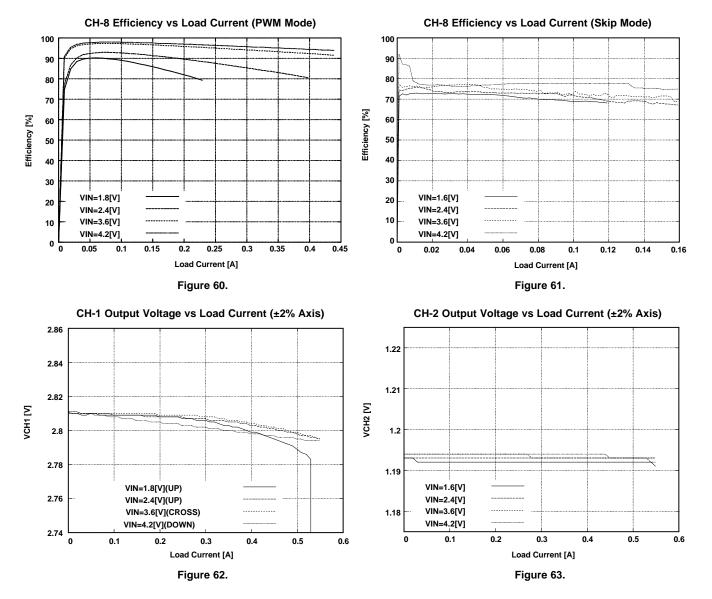
Figure 51.



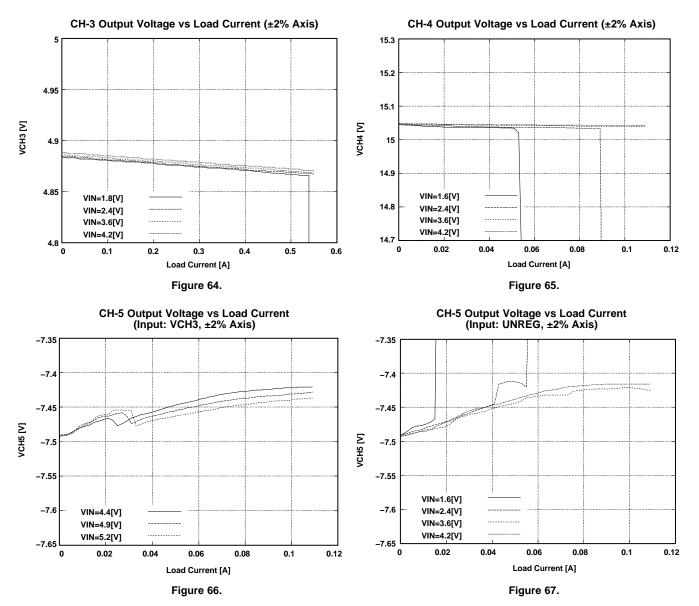




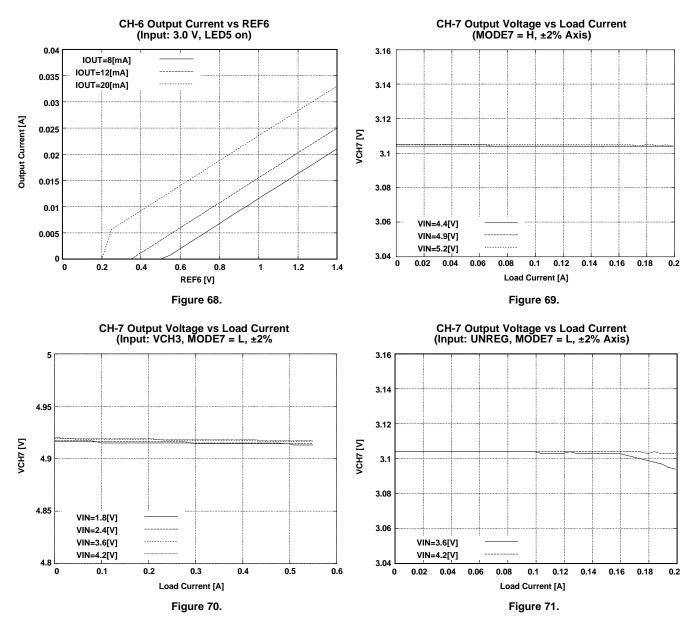


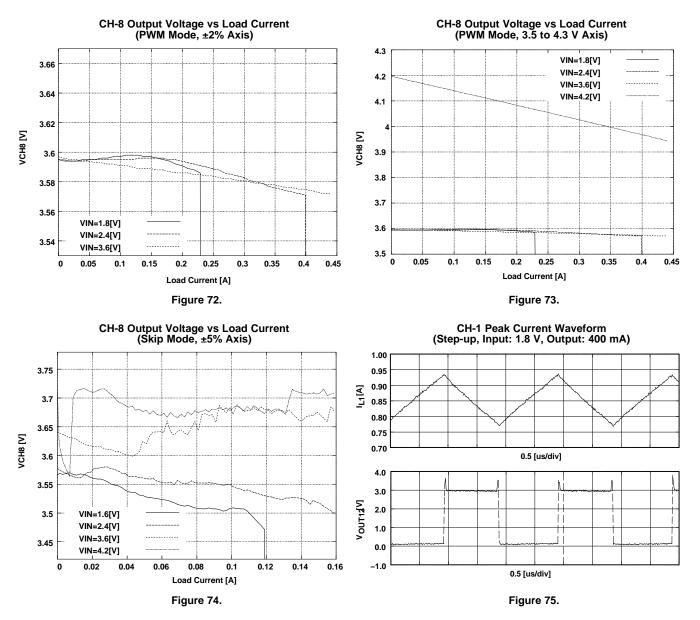


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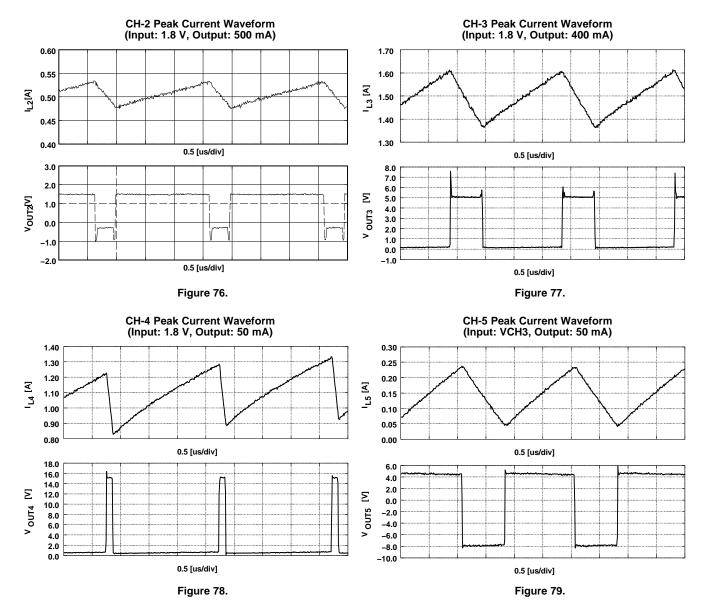


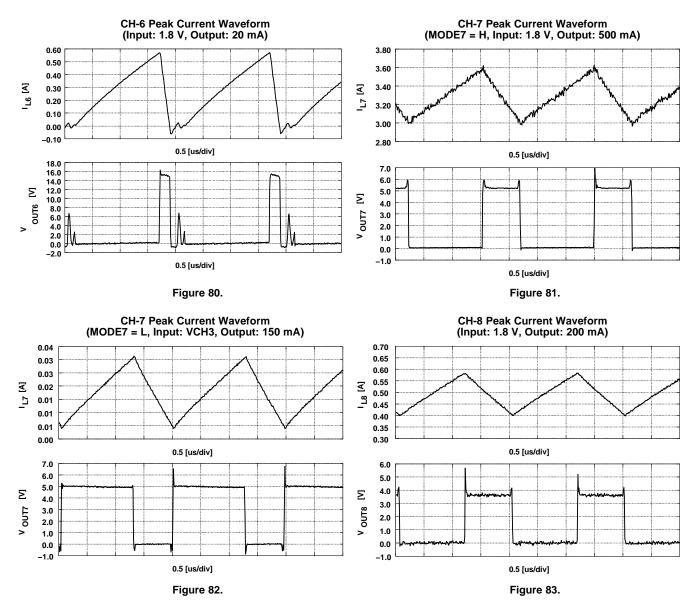














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| TPS65520ZVDR | OBSOLETE | NFBGA | ZVD | 113 | | TBD | Call TI | Call TI | |

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